

# NORA-W36 series

## u-connectXpress dual-band Wi-Fi and Bluetooth modules

### System integration manual



### Abstract

This manual describes the system integration of the NORA-W36 series stand-alone, dual-band Wi-Fi and Bluetooth Low Energy modules. The modules are ultra-compact, cost-efficient, multi-radio modules in the NORA form factor, designed for a wide range of industrial applications. This module series includes variants with or without an internal antenna. These modules feature a number of useful embedded security features, including secure boot that ensures that only authenticated software can run on the module. NORA-W36 modules are ideal for critical IoT applications where security is important. The modules connect to a host system using high-speed UART interface.


# Document information

<b>Title</b>	<b>NORA-W36 series</b>	
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This document applies to the following products:

Product name	Document status	Comment
NORA-W361	Early production information	
NORA-W366	Early production information	

 For information about the related hardware, software, and status of listed product types, refer to the data sheet [\[2\]](#).

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# 1 Module overview

NORA-W36 series are small, stand-alone dual-band Wi-Fi and Bluetooth Low Energy microcontroller unit (MCU) modules – perfect for integrating wireless connectivity in end products.

With Wi-Fi 4 (802.11a/b/g/n) in the 2.4 and 5 GHz bands, NORA-W36 can be used as Wi-Fi station that connects to a remote access point or otherwise act as an access point. NORA-W36 is qualified for Bluetooth 5.3 connectivity and can assume peripheral or central roles, or both simultaneously. It can also be a GATT client or server.

Including pre-flashed u-connectXpress software, end-product integration is simplified, and time-to-market reduced. The host controller configures and controls the wireless communication using high-level AT commands without need for expertise in Wi-Fi and Bluetooth protocols stacks.

The module embeds a dual-core MCU with a powerful Arm® Cortex®-M33 compatible processor for the main application and an Arm Cortex-M23 compatible core for low power operation.

The NORA-W36 series includes hardware security features like secure boot, trusted execution environment with Arm TrustZone®, encrypted flash, protection of debug port, and a crypto acceleration engine. Wireless communication is secure with WPA2/WPA3 authentication, TLS encryption, Bluetooth LE secure connection pairing.

NORA-W36 modules have the same size and position of critical pads and interfaces as other NORA modules. This offers maximum flexibility for the development of similar end-devices with different radio technologies. The modules support operation in an extended temperature range of –40°C to +105°C and are qualified for professional grade applications.

## 1.1 Module architecture

NORA-W36 series modules are based on the Realtek RTL8720DF chip. Module variants allow developers to select either an external antenna with NORA-W360 and NORA-W361 or an on-module antenna with NORA-W366.

These compact modules include the MCU, flash memory, crystal, and other components for matching, filtering, antenna, decoupling, and antenna operation.

The two variants of NORA-W36 series are described in [Table 1](#).

Variant / Ordering code	Antenna configuration	Antenna type
NORA-W360-00B	U.FL: 2.4 GHz / 5 GHz Wi-Fi, 2.4 GHz Bluetooth LE	U.FL connector
NORA-W361-00B	RF_ANT0: 2.4 GHz / 5 GHz Wi-Fi, 2.4 GHz Bluetooth LE	Antenna pad
NORA-W366-00B	Combined 2.4 GHz / 5 GHz Wi-Fi, 2.4 GHz Bluetooth LE	Single embedded PCB antenna

**Table 1: Supported configurations of the NORA-W36 series**

### 1.1.1 Block diagram

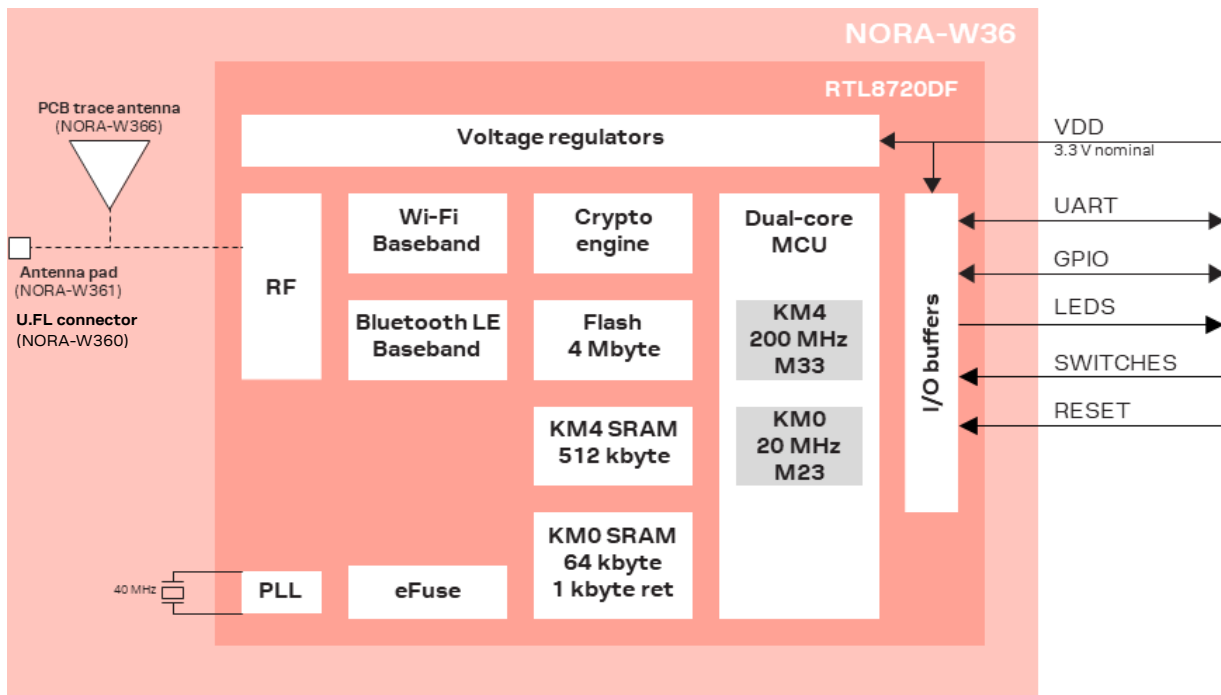
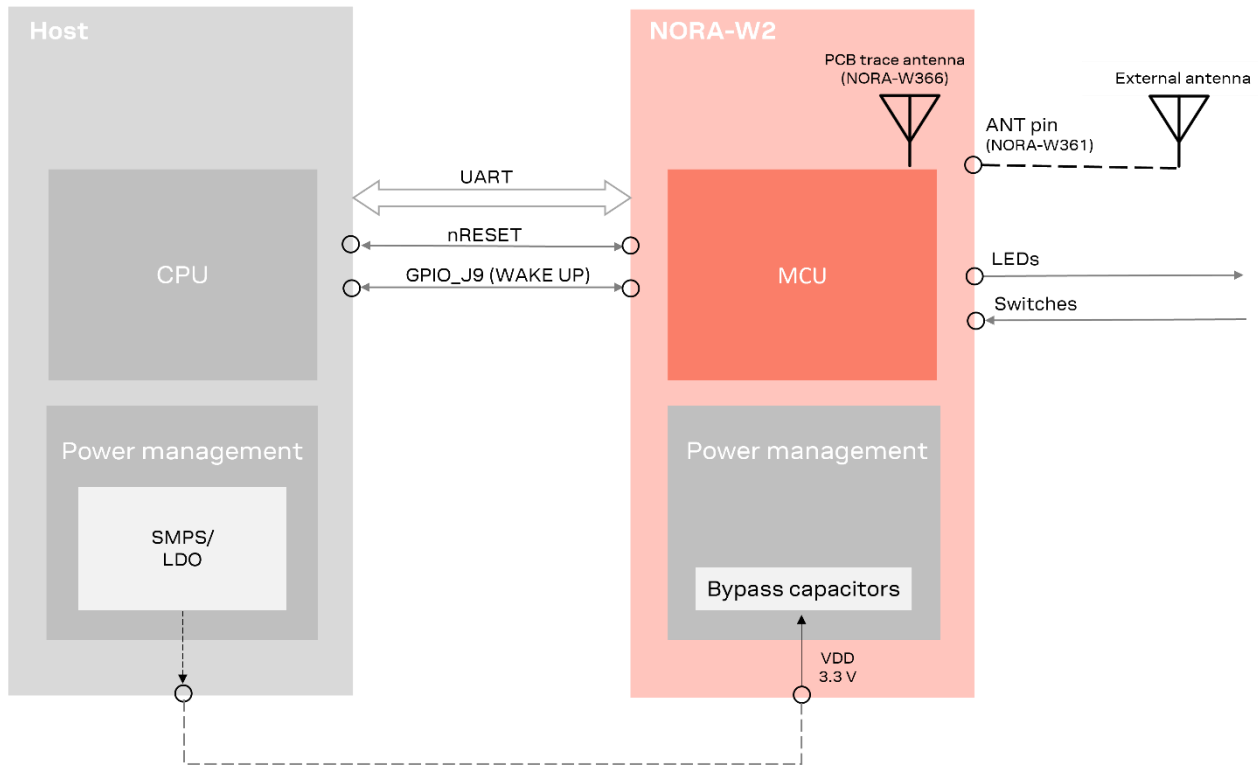


Figure 1: NORA-W36 series block diagram

## 2 Module integration

NORA-W36 must be integrated together with a host CPU, as shown in [Figure 2](#).



**Figure 2: NORA-W36 integration in host system**

The module is controlled by the host CPU using the **nRESET** and UART signals. The power supply is sourced from the **VCC** and **VIO** pins.

Observe these design considerations when integrating the module with the host system:

- If not used in the host board design, test points for LEDs, switches, and GPIO signals should be considered in the integration.
- NORA-W361 supports U.FL connector pads for use with an external antenna, which is mandatory if the application is hosted in a metal enclosure.
- NORA-W366 has an integrated antenna and is suitable for products mounted in a plastic housing.

### 2.1 Power management

#### 2.1.1 System supply (VDD) and digital I/O reference

NORA-W36 has a single power supply input, **VDD**, which is also the I/O voltage reference. The nominal voltage is 3.3 VDC  $\pm 10\%$ .

#### 2.1.2 Power supply configuration

NORA-W3 can be configured for operating the MCU cores with a switch mode power supply (SMPS), standby power supply (SPS). SPS is the default configuration. LDO configuration is selected by changing the strapping, though SPS mode is recommended for greatest power efficiency.




### 2.1.3 VDD application circuits

The power to NORA-W36 series modules is applied through the **VDD** pins. These supplies are taken from either of the following sources:

- SMPS
- LDO

An SMPS is the ideal design choice when the available primary supply source is significantly higher than the operating supply voltage of the module. This offers the best power efficiency for the application design and minimizes the amount of current drawn from the main supply source.

 When taking **VDD** supplies from an SMPS make sure that the AC ripple voltage is kept as low as possible at the switching frequency. Design layouts should focus on minimizing the impact of any high-frequency ringing.

Use an LDO linear regulator for primary VDD supplies that have a relatively low voltage. As LDO regulators dissipate power linearly related to the step-down voltage, LDOs are not recommended for step down of high voltages.

DC-DC efficiency should be regarded as a trade-off between the active and idle duty cycles of an application. Although some DC-DC devices achieve high efficiency at light loads, these efficiencies typically degrade as soon as the idle current drops below a few milliamps. This can have a negative impact on the life of a battery.

If decoupling capacitors are needed on the supply rails, it is best practice to position these as close as possible to the NORA-W36 series module. The power routing of some host system designs makes decoupling capacitance unnecessary.


For electrical specifications, see also the appropriate NORA-W36 series data sheet [\[2\]](#).

## 2.2 Module reset

The logic level of **nRESET** pin is set high using an internal pull-up resistor. To reset (reboot) the module hardware, drive this signal low, with an open drain, open collector, or contact switch. For information about the pin characteristics, see the data sheet [\[2\]](#).

## 2.3 Power saving modes

NORA-W36 supports different power saving modes for optimizing the power consumption.

 Auto sleep is not available with u-connectXpress v1.0.0, will be supported in later versions

### 2.3.1 Auto sleep

In Auto sleep mode, the module can maintain Wi-Fi and Bluetooth Low Energy connections. The u-connectXpress software automatically controls the power-saving capabilities of the module based on a configurable power-saving level and application activity. The power-saving level can be set to prioritize current consumption savings or module performance (e.g., throughput and latency).

- Auto sleep mode is enabled, and power save level is configured using a AT command.
- When enabled, no further action is required by the host.

For more information about this and other commands, see also the u-connectXpress AT command manual [\[12\]](#).

### 2.3.2 Deep sleep

Deep sleep mode is used to minimize current consumption. In this mode, the UART interface is disabled, and no Wi-Fi and Bluetooth Low Energy connections are maintained.

The host needs to control when the module should enter and exit Deep sleep mode. After wake up, the module assumes the same state as it does after a reset.

- To initiate Deep sleep mode, the host uses the AT command **AT+UPMDS**.
- To wake up the module from Deep sleep mode, the host sets **GPIO\_J9** to GND.

For more information about this and other commands, see also the u-connectXpress AT command manual [12].

## 2.4 Antenna integration

Antenna interfaces are different for each module variant in the NORA-W36 series. The modules support either an internal antenna (NORA-W366) or external antennas connected through a dedicated antenna pin (NORA-W361) or U.FL connector (NORA-W360).

### 2.4.1 External antenna interface

The NORA-W361 module is equipped with an antenna signal (**ANT**) pin. The pin has a nominal characteristic impedance of 50  $\Omega$  and must be connected to the antenna through a 50  $\Omega$  transmission line.

The NORA-W360 module is equipped with a U.FL connector for connection to a 50  $\Omega$  transmission line.

Choose an antenna with optimal radiating characteristics for the best electrical performance and overall module functionality. An internal antenna, integrated on the application board or an external antenna connected to the application board through a proper 50  $\Omega$  connector, can be used.

When using an external antenna, the PCB-to-RF-cable transition must be implemented using either a suitable 50  $\Omega$  connector, or an RF-signal solder pad (including GND) that is optimized for 50  $\Omega$  characteristic impedance.

#### 2.4.1.1 Antenna matching


The antenna return loss should be as low as possible across both bands to provide optimal performance. The enclosure, shields, other components, and surrounding environment might impact the return loss that is seen at the antenna port. Matching components are often required to retune the antenna to 50  $\Omega$  characteristic impedance.

It is difficult to predict the actual matching values for the antenna in the final form factor. Therefore, it is good practice to have a placeholder in the circuit with a “pi” network, with two shunt components and a series component in the middle. This allows maximum flexibility while tuning the matching to the antenna feed.

#### 2.4.1.2 Approved antenna designs

NORA-W361 modules come with a pre-certified design that utilizes a U.FL connector for an external antenna. The certification can be used to save costs and time during the certification process. See also [Approved antennas](#).

The designer integrating a u-blox reference design into an end-product is solely responsible for any unintentional RF emission generated by the end product.

 The module may be integrated with other antennas. In which case, the OEM installer must certify the design with respective regulatory agencies.

## 2.4.2 Internal antenna

NORA-W366 modules have an internal antenna that is specifically designed and optimized for u-blox Wi-Fi, and Bluetooth LE modules. With NORA-W366, designers only need to consider the module placement and GND clearance in antenna area.

## 2.5 Data interfaces

NORA-W36 modules have six I/O pins. The pins are assigned to the data interfaces listed below, but the assignments can't be in conflict. Some GPIO are used for low power modes. For more information, see also [Power saving modes](#).

### 2.5.1 UART (Universal Asynchronous Receiver Transmitter)


NORA-W36 supports a high-speed UART interface with a maximum baud rate of 4 Mbps. The host application uses this interface to configure and control the module. Additionally, it can be used to upgrade the [Software](#).

The UART interface support the following signals:

- Data lines (**RXD** as input, **TXD** as output)
- Hardware flow control lines (**CTS** as input, **RTS** as output)

You can use the UARTs in 4-wire mode with hardware flow control, or in 2-wire (default) mode with **TXD** and **RXD** only.

Default interface settings are 115 200 bps, 8 data bits, no parity, 1 stop bit, with no flow control.

 To avoid buffer overrun, UART operation in 2-wire mode is not recommended for speeds above 115 200 bps.

## 2.6 General purpose input/output

**GPIO\_J9** is used as the Deep sleep wake-up signal described in [Power saving modes](#).

Two GPIO pins **GPIO SWITCH\_1** and **SWITCH\_2** are used to enter bootloader, as shown in [Table 2](#).

Pin	State during boot	Behavior
SWITCH_1, SWITCH_2	Low (0), Low (0)	Enter bootloader. If this state is still kept for more than 10 seconds without sending commands to bootloader over UART, the u-connectXpress application boots. The module settings are then restored to factory default values.
	Low (0), High (1)	Boots the u-connectXpress application.
	High (1), Low (0)	
	High (1), High (1)	


**Table 2: NORA-W36 series boot mode pins**

The internal pull up values are the default states for NORA-W36 on boot.

For information about updating the software, see also [u-connectXpress software](#).

## 2.7 u-connectXpress software debug output

For debugging purposes, the NORA-W36 u-connectXpress software allows diagnostic logging data to be sent over a secondary UART interface. The serial data is transmitted to the **DBG\_TX** pin at a baud rate of 115 200 bps.

 The **DBG\_TX** pin must be exposed and made available for u-blox to debug the module should the need arise.

## 2.8 No-connect pins

Don't connect No-Connect (NC) pins. These pins are allocated for future functionality.

## 2.9 Ground (GND) pins

For correct RF performance, a good electrical connection to all module GND pins, using the solid ground layer of the host application board, is necessary. Firm connections provide a thermal heat sink for the module and significantly reduce EMC issues.

## 3 Design-in

Follow the design guidelines stated in this chapter to optimize the integration of NORA-W36 series modules in your application board.


### 3.1 Overview

Although all application circuits must be properly designed, there are several points that demand special attention during application design. A list of these points, in order of importance, follows:

- **Module antenna connection: ANT pad (NORA-W361 only)**  
Antenna circuits affect the RF compliance of all applications that include the certification schemes related to the module. To maintain compliance and subsequent certification of the application design, it is important to observe the applicable parts of antenna schematic and layout design described in [Antenna interface](#).
- **Module supply: VDD and GND pins.**  
Supply circuits can affect the RF performance. It is important to observe the schematic and layout design for these supplies. See also [VDD application circuits](#). Modules normally include several supply pins described in the pin out of the NORA-W36 data sheet [2].
- **High-speed data interfaces: UART.**  
High-speed data interfaces are a potential source of radiated noise that can affect the regulatory compliance standards for radiated emissions. It is important to follow the schematic and layout design recommendations described in the [General high-speed layout guidelines](#).
- **System functions: nRESET, GPIO, and other System input and output pins**  
Careful utilization of these pins in the application design is required to guarantee correct boot up and system operation. Ensure that the voltage level is correctly defined during module boot. It is important to follow the schematic and layout design recommendations described in [General high-speed layout guidelines](#).
- **Other pins: ADC and NC pins.**  
Careful utilization of these pins is required to guarantee proper functionality. It is important to follow the schematic and layout design recommendations described in the [General high-speed layout guidelines](#).

### 3.2 Antenna interface

The module cannot be mounted arbitrarily. Placement should be chosen with consideration so that it does not interfere with radio communication. NORA-W366 modules that include an internal PCB trace antenna can't be mounted in a metal enclosure. No metal casing or plastics using metal flakes should be used. Avoid metallic based paint or lacquer as well. NORA-W361 modules offer more freedom as an external antenna can be mounted further away from the module.

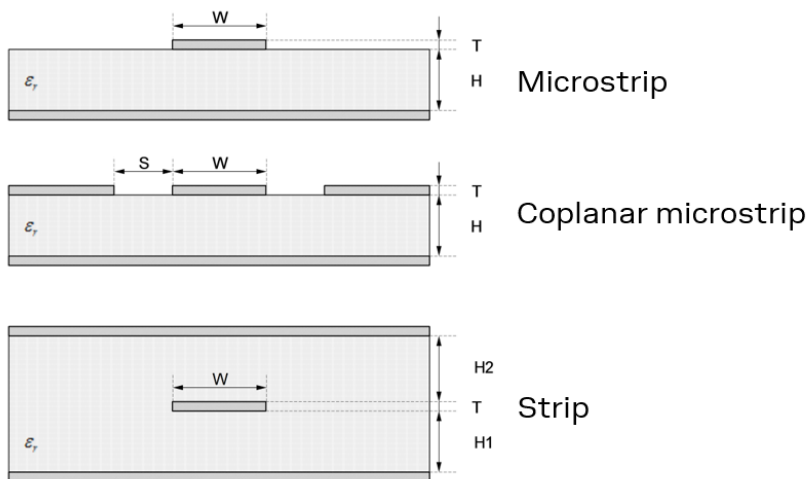
-  According to FCC regulations, the transmission line, from the module antenna pin to the antenna or antenna connector on the host PCB, is considered part of the approved antenna design. Therefore, module integrators must either follow exactly one of the antenna reference designs used in the module's FCC type approval or certify their own designs.

### 3.2.1 RF transmission line design (NORA-W361)

RF transmission lines, such as the ones from the **ANT** pad up to the related internal antenna pad, must be designed so that the characteristic impedance is as close as possible to  $50\ \Omega$ .

Design options and the most important parameters for implementing a transmission line on a PCB are described below:

- Microstrip: track separated with dielectric material and coupled to a single ground plane.
- Coplanar microstrip: track separated with dielectric material and coupled to both the ground plane and side conductor.
- Stripline: track separated by dielectric material and sandwiched between two parallel ground planes.



**Figure 3: Transmission line trace design**

Follow these recommendations to design a  $50\ \Omega$  transmission line correctly:

- The designer should provide enough clearance from surrounding traces and ground in the same layer; in general, a trace to ground clearance of at least two times the trace width should be considered. The transmission line should also be “guarded” by ground plane area on each side.
- The characteristic impedance can be calculated as first iteration using tools provided by the layout software. It is advisable to ask the PCB manufacturer to provide the final values that are usually calculated using dedicated software and available stack-ups from production. It could also be possible to request an impedance coupon on panel’s side to measure the real impedance of the traces.
- FR-4 dielectric material, although it has high losses at high frequencies, can be considered in RF designs provided that:
  - RF trace length must be minimized to reduce dielectric losses.
  - If traces longer than a few centimeters are needed, it is recommended to use a coaxial connector and cable to reduce losses
  - Stack-up should allow for thick  $50\ \Omega$  traces and at least  $200\ \mu\text{m}$  trace width is recommended to assure good impedance control over the PCB manufacturing process.
  - FR-4 material exhibits poor thickness stability and thus less control of impedance over the trace length. Contact the PCB manufacturer for specific tolerance of controlled impedance traces.
- The transmission lines width and spacing to the GND must be uniform and routed as smoothly as possible: route RF lines in arcs (preferred) or  $45^\circ$  angles.
- Add GND stitching vias around transmission lines.

- Ensure solid metal connection of the adjacent metal layer on the PCB stack-up to main ground layer, providing enough vias on the adjacent metal layer.
- Route RF transmission lines far from any noise source (for example, switching supplies and digital lines) and from any sensitive circuit to avoid crosstalk between RF traces and high impedance or analog signals.
- Avoid stubs on the transmission lines, any component on the transmission line should be placed with the connected pad over the trace. Also avoid any unnecessary components on RF traces.

### 3.2.2 Antenna design (NORA-W361)

NORA-W361 is suited for designs when an external antenna is needed due to mechanical integration or placement of the module.

Designers must take care of the antennas from all perspective at the beginning of the design phase when the physical dimensions of the application board are under analysis/decision, as the RF compliance of the device integrating NORA-W361 module with all the applicable required certification schemes heavily depends on the radiating performance of the antennas. Designers are encouraged to consider one of the u-blox suggested antenna part numbers and follow the layout requirements.

- External antennas such as those listed in the [Pre-approved antenna list](#):
  - External antennas don't imply physical restriction to the design of the PCB where the module is mounted.
  - The radiation performance mainly depends on the antennas. It is required to select antennas with optimal radiating performance in the operating bands.
  - RF cables should carefully be selected with minimum insertion losses. Additional insertion loss will be introduced by low quality or long cable. Large insertion loss reduces radiation performance.
  - A high quality 50  $\Omega$  coaxial connector provides proper PCB-to-RF-cable transition.
- Integrated antennas such as patch-like antennas:
  - Internal integrated antennas imply physical restriction to the PCB design:
 

Integrated antenna excites RF currents on its counterpoise. Typically, the PCB ground plane of the device that becomes part of the antenna, and its dimension defines the minimum frequency that can be radiated. Therefore, the ground plane can be reduced to a minimum size that should be similar to the quarter of the wavelength of the minimum frequency that has to be radiated. Given that, the orientation of the ground plane related to the antenna element must be considered.

The RF isolation between antennas in the system must be as high as possible and the correlation between the 3D radiation patterns of the two antennas must be as low as possible. In general, an RF separation of at least a quarter wavelength between the two antennas is required to achieve a maximum isolation and low pattern correlation. Increased separation should be considered, if possible, to maximize the performance and fulfil the requirements described in [Table 3](#). As a numerical example, the physical restriction to the PCB design can be considered as shown below:

Frequency = 2.4 GHz  $\rightarrow$  Wavelength = 12.5 cm  $\rightarrow$  Quarter wavelength = 3.125 cm<sup>1</sup>
  - Radiation performance depends on the whole product and antenna system design, including product mechanical design and usage. Antennas should be selected with optimal radiating performance in the operating bands according to the mechanical specifications of the PCB and the whole product.

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<sup>1</sup> Wavelength referred to a signal propagating over the air.

Table 3 summarizes the requirements for the antenna RF interface:

Item	Requirements	Remarks
<b>Impedance</b>	50 $\Omega$ nominal characteristic impedance	The impedance of the antenna RF connection must match the 50 $\Omega$ impedance of the <b>ANT</b> pin.
<b>Frequency Range</b>	2400 – 2500 MHz 5150 – 5850 MHz	Wi-Fi and Bluetooth Wi-Fi
<b>Return Loss</b>	$S_{11} < -10$ dB (VSWR < 2:1) recommended $S_{11} < -6$ dB (VSWR < 3:1) acceptable	The Return loss ( S ) as the VSWR refers to the amount of reflected power, measuring how well the primary antenna RF connection matches the 50 $\Omega$ characteristic impedance of the <b>ANT</b> pin. The impedance of the antenna termination must match as much as possible the 50 $\Omega$ nominal impedance of the <b>ANT</b> pin over the operating frequency range, thus maximizing the amount of the power transferred to the antenna.
<b>Efficiency</b>	> -1.5 dB ( > 70% ) recommended > -3.0 dB ( > 50% ) acceptable	The radiation efficiency is the ratio of the radiated power to the power delivered to the antenna input; the efficiency is a measure of how well an antenna receives or transmits.
<b>Maximum Gain</b>	Refer to Data sheet	The maximum antenna gain must not exceed the value specified in type approval documentation to comply with the radiation exposure limits specified by regulatory agencies.

**Table 3: Summary of antenna interface (ANT) requirements for NORA-W361**

Observe the following recommendations while selecting external or internal antennas:

- Select antennas that provide optimal return loss, based on the Voltage Standing Wave Ratio (VSWR) figure, over all the operating frequencies.
- Select antennas that provide an optimal efficiency figure over all the operating frequencies.
- Select antennas that provide an appropriate gain figure (that is, combined antenna directivity and efficiency figure) so that the electromagnetic field radiation intensity does not exceed the regulatory limits specified in some countries (by FCC in the United States for example).

### 3.2.2.1 RF connector design

If an external antenna is required, designers should consider using a proper RF connector. It is the responsibility of the designer to verify the compatibility between plugs and receptacles used in the design.

Table 4 suggests several RF connectors that designers can use to connect RF coaxial cables - based on the declaration of the respective manufacturers. Hirose U.FL-R-SMT RF receptacles (or similar parts) require suitable mated RF plugs from the same connector series. Due to wide usage of this connector, several manufacturers offer compatible equivalents.

Manufacturer	Series	Remarks
Hirose	U.FL® Ultra Small Surface Mount Coaxial Connector	Recommended
I-PEX	MHF® Micro Coaxial Connector	
Tyco	UMCC® Ultra-Miniature Coax Connector	
Amphenol RF	AMC® Amphenol Micro Coaxial	
Lighthouse Technologies, Inc.	IPX ultra micro-miniature RF connector	


**Table 4: U.FL compatible connectors**



Typically, the RF plug is available as a cable assembly. Different types of cable assembly are available; the end product designer should select the cable assembly best suited to the application. The key characteristics of a suitable cable assembly include:

- RF plug type: select U.FL or equivalent
- Nominal impedance: 50  $\Omega$
- Cable thickness: Typically, from 0.8 mm to 1.37 mm. Select thicker cables to minimize insertion loss.
- Cable length: Standard length is typically 100 mm or 200 mm; custom lengths may be available on request. Select shorter cables to minimize insertion loss.
- RF connector on the other side of the cable: For example, another U.FL (for board-to-board connection) or SMA (for panel mounting).

Consider that SMT connectors are typically rated for a limited number of insertion cycles. Additionally, the RF coaxial cable may be relatively fragile compared to other types of cables. To increase application ruggedness, connect U.FL connector to a more robust connector such as SMA fixed on panel.

 A de-facto standard for SMA connectors implies the usage of reverse polarity connectors (RP-SMA) on Wi-Fi and Bluetooth® end products to increase the difficulty for the end user to replace the antenna with higher gain versions and exceed regulatory limits.

The following recommendations apply for the proper layout of the connector:

- Strictly follow the connector manufacturer's recommended layout:
  - SMA Pin-Through-Hole connectors require GND keep-out (that is, clearance, a void area) on all the layers around the central pin up to annular pads of the four GND posts.
  - U.FL surface mounted connectors require no conductive traces (that is, clearance, a void area) in the area below the connector between the GND land pads.

If the connector's RF pad size is wider than the micro strip, remove the GND layer beneath the RF connector to minimize the stray capacitance thus keeping the RF line 50  $\Omega$ . For example, the active pad of the U.FL connector must have a GND keep-out (that is, clearance, a void area) at least on the first inner layer to reduce parasitic capacitance to ground.

### 3.2.2.2 Integrated antenna design

If integrated antennas are used, the transmission line is terminated by the integrated antennas themselves. Follow the guidelines mentioned below:

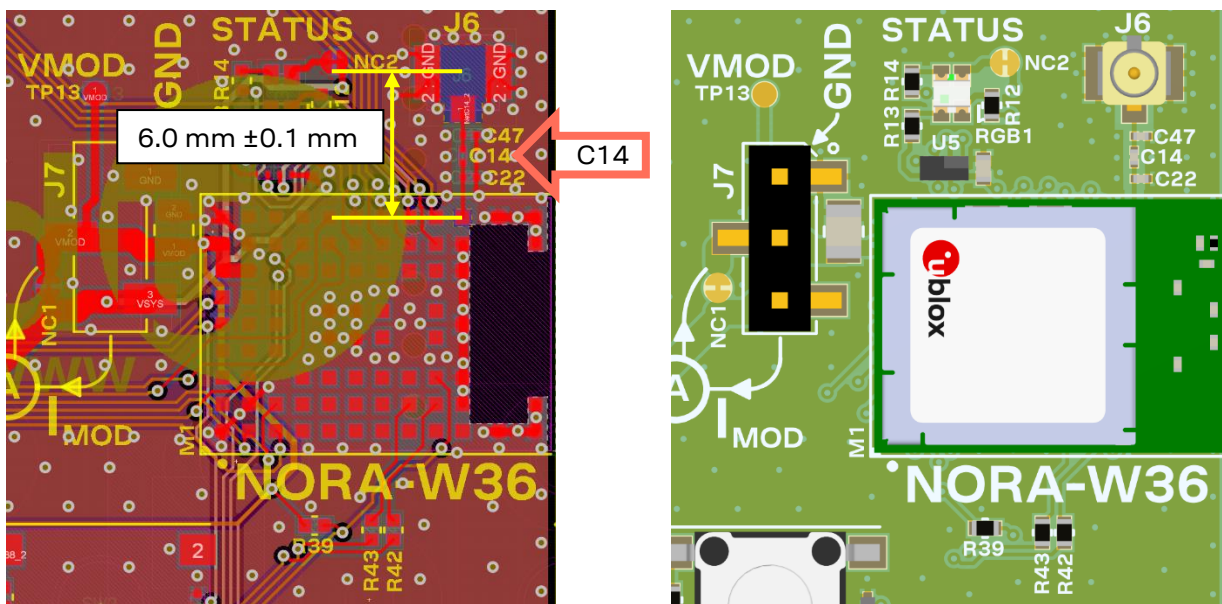
- The antenna design process should begin at the start of the whole product design process. Self-made PCBs and antenna assembly are useful in estimating overall efficiency and radiation path of the intended design.
- Use antennas designed by an antenna manufacturer providing the best possible return loss (or VSWR).
- Provide a ground plane large enough according to the related integrated antenna requirements. The ground plane of the application PCB may be reduced to a minimum size that must be similar to one quarter of wavelength of the minimum frequency that has to be radiated; however overall antenna efficiency may benefit from larger ground planes.
- Proper placement of the antenna and its surroundings is also critical for antenna performance. Avoid placing the antenna close to conductive or RF-absorbing parts such as metal objects, ferrite sheets and so on as they may absorb part of the radiated power or shift the resonant frequency of the antenna or affect the antenna radiation pattern.
- It is highly recommended to strictly follow the detailed and specific guidelines provided by the antenna manufacturer regarding correct installation and deployment of the antenna system, including PCB layout and matching circuitry.

- Further to the custom PCB and product restrictions, antennas may require tuning/matching to comply with all the applicable required certification schemes. It is recommended to consult the antenna manufacturer for the design-in guidelines and plan the validation activities on the final prototypes like tuning/matching and performance measures. See also [Table 3](#).
- RF section may be affected by noise sources like hi-speed digital buses. Avoid placing the antenna close to buses such as DDR or consider taking specific countermeasures like metal shields or ferrite sheets to reduce interference.

Give due consideration to the interaction between co-located RF systems like LTE sidebands on the 2.4 GHz band. Transmitted power can interact or disturb the performance of NORA-W36 modules.

### 3.2.3 NORA-W361 U.FL reference design

[Figure 4](#) shows the U.FL connector (J6) for connecting an approved external antenna. When using a pi network, a 10pF 0201 series capacitor, similar to that shown as C14 in [Figure 4](#), should be used.



**Figure 4: NORA-W361 approved U.FL antenna connection – 2D and 3D views**

Distance from the center of the antenna pin to the center of the U.FL connector is 6.0 mm ± 0.1 mm. Trace width from the antenna pin to the series capacitor and U.FL connector is 0.2 mm ± 0.01 mm. C47 and C22 are not populated.

The keep-out area under NORA-W361 or NORA-W360 is not required.

The layer stack-up is shown in [Figure 5](#).

#	Name	Material	Type	Weight	Thickness	Dk
	Top Overlay		Overlay			
	Top Solder	Solder Resist	Solder Mask		0.0127mm	3.5
1	L1		Signal	1oz	0.035mm	
	Dielectric 1	Composite dielectric	Prepreg		0.11mm	4.29
2	L2		Signal	1oz	0.035mm	
	Core	Composite dielectric	Core		1.2mm	4.29
3	L3		Signal	1oz	0.035mm	
	Dielectric 3	Composite dielectric	Prepreg		0.11mm	4.29
4	L4		Signal	1oz	0.035mm	
	Bottom Solder	Solder Resist	Solder Mask		0.0127mm	3.5
	Bottom Overlay		Overlay			

**Figure 5: NORA-W361 host board approved layer stack-up**

See Appendix A: [Reference trace design \(NORA-W3x1 only\)](#) for full trace design details.

### 3.2.4 On-board antenna design (NORA-W366)

If a plastic enclosure is used, it is possible to use NORA-W366 with the embedded antenna. To reach optimum operating performance, follow the instructions in this section.

#### 3.2.4.1 NORA-W366 – PCB trace antenna

- The module shall be placed in the center of an edge of the host PCB.
- A large ground plane on the host PCB is a prerequisite for good antenna performance. It is recommended to have the ground plane extending at least 10 mm on the three non-edge sides of the module. See also [Figure 6](#).
- The host PCB shall include a full GND plane underneath the entire module, with a ground cut out under the PCB trace antenna according to the description in [Figure 7](#).
- The NORA-W366 has six extra GND pads under the antenna that need to be connected for a good antenna performance. Detailed measurements of the footprint including this extra GND pads can be found in the NORA-W36 series datasheet [\[2\]](#).
- High / large parts that include metal shall not be placed closer than 10 mm to the module antenna.
- At least 10 mm clearance between the antenna and the casing is recommended. If the clearance is less than 10 mm, the antenna performance can be adversely affected.
- The module shall be placed such that the antenna faces outwards from the product and is not obstructed by any external items in close vicinity of the products intended use case.
- Keep a minimum clearance of 5 mm between the antenna and any casing. Also, keep at least 10 mm of free space around the metal antenna including the area directly below it. If a metal enclosure is required, use NORA-W361 or NORA-W360 and an external antenna.
- It is beneficial to have a large solid ground plane on the host PCB with a good grounding on the module. Minimum ground plane size is 24x30 mm but more than 50x50 mm is recommended.

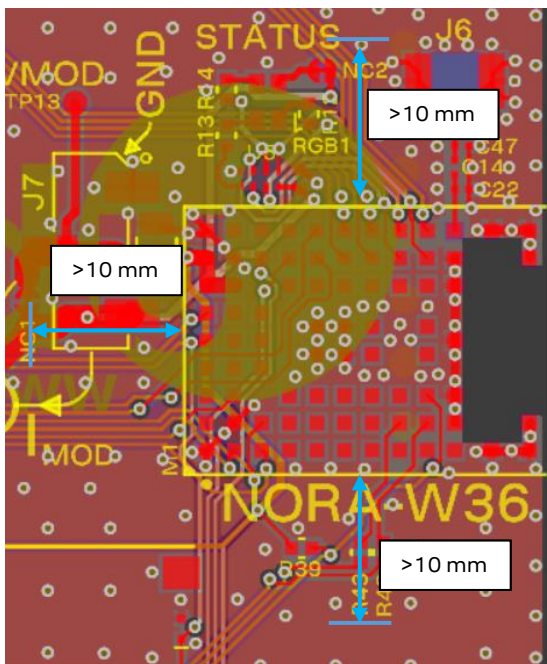


Figure 6: GND plane guard area enclosing NORA-W366

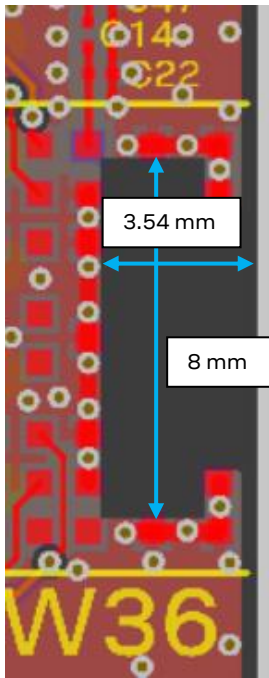


Figure 7: Size of the GND cut out for the NORA-W36 PCB trace antenna

### 3.3 Data communication interfaces

#### 3.3.1 Asynchronous serial interface (UART) design


The layout of the UART bus should be implemented so that noise injection and cross talk are avoided. It is advisable to use the hardware flow control with RTS/CTS to prevent temporary UART buffer overrun.

The flow control signals **RTS/CTS** are active low. Consequently, 0 (ON state = low level) allows the UART to transmit.

- **CTS** is an input to the NORA-W36 module. If the host sets this input to 0 (ON state = low level) the module can transmit.
- **RTS** is an output from the NORA-W36 module. The module sets the output to 0 (ON state = low level) when it is ready to receive transmission.

### 3.4 General high-speed layout guidelines

These guidelines describe the best schematic and layout practices for integrating the module on a host PCB. Designers should prioritize the layout of higher speed buses. Low frequency signals, other than those with high-impedance traces, are generally not layout critical.

-  Low frequency signals with high-impedance traces (such as signals driven by weak pull resistors) may be affected by crosstalk. For these high-impedance traces, a supplementary isolation of  $4 \times W$  from other buses is recommended.

#### 3.4.1 Considerations for schematic design and PCB floor-planning

- Verify which signal bus requires termination and add series resistor terminations to the schematics.
- Carefully consider the placement of the module with respect to antenna position.
- Verify with PCB manufacturer allowable stack-ups and controlled impedance dimensioning.

- Verify that the power supply design and power sequence are compliant with the specification of NORA-W36 series module.

### 3.4.2 Component placement

- Accessory parts like bypass capacitors should be placed as close as possible to the module to improve filtering capability, prioritizing the placement of the smallest size capacitor close to module pads.
- Don't place components close to the antenna area. Follow the recommendations of the antenna manufacturer to determine distance of the antenna in relation to other parts of the system. Designers should also maximize the distance of the antenna to high-frequency busses, like DDRs and related components. Alternatively, consider an optional metal shield to reduce interference that might otherwise be picked up by the antenna and subsequently reduce module sensitivity.
- An optimized module placement allows better RF performance. For more information about the module placement and other antenna considerations, see also [Antenna requirements](#).

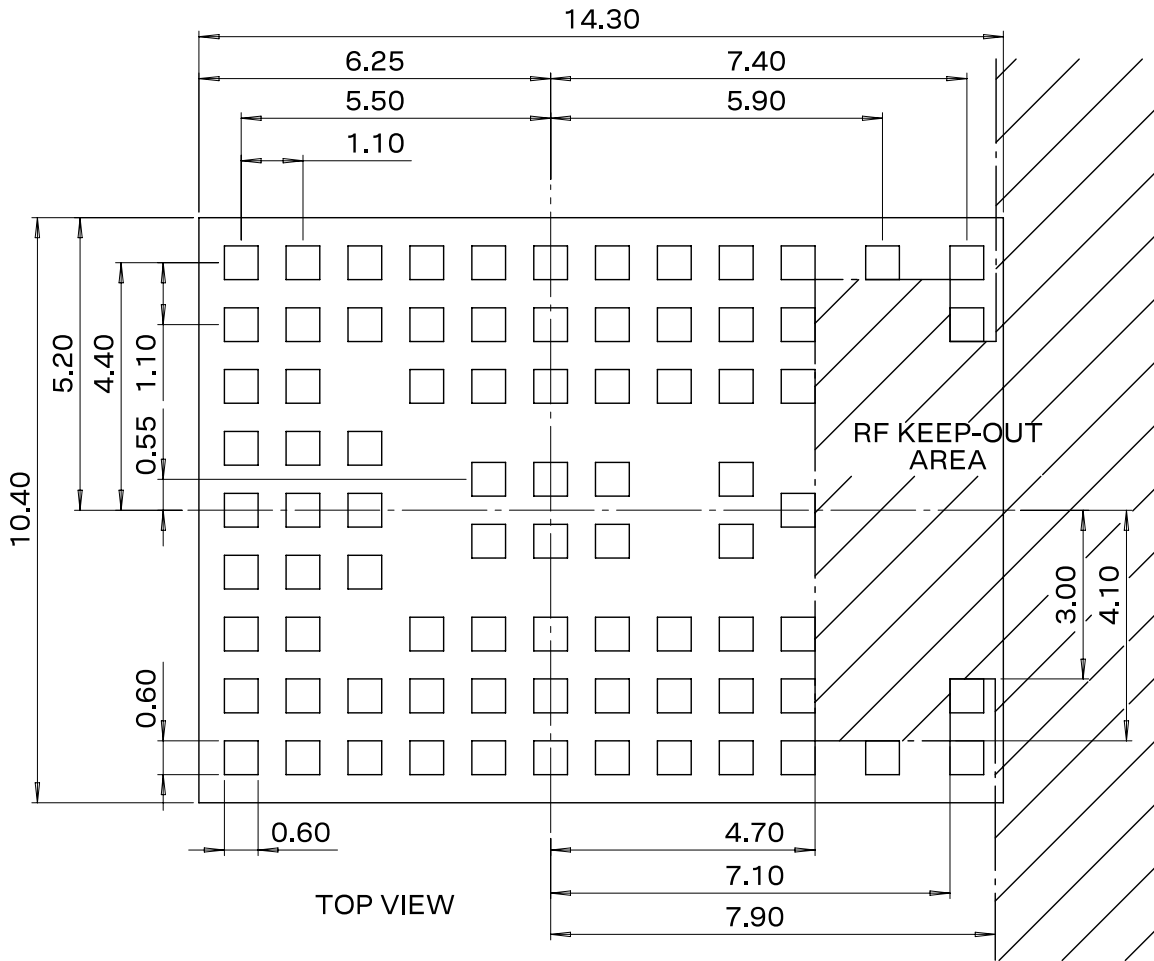
### 3.4.3 Layout and manufacturing

- Avoid stubs on high-speed signals. Test points or component pads should be placed over the PCB trace.
- Verify the recommended maximum signal skew for differential pairs and length matching of buses.
- Minimize the routing length; longer traces degrade signal performance. Ensure that the maximum allowable length for high-speed buses is not exceeded.
- Be sure to track your impedance matched traces. Consult early with your PCB manufacturer for proper stack-up definition.
- RF, analog, and digital sections should have dedicated and clearly separated areas on the board.
- No digital routing is allowed in the GND reference plane area of RF traces (**ANT** pin and antenna).
- Designers are strongly recommended to avoid digital routing beneath all layers of RF traces.
- Ground cuts or separation are not allowed under the module.
- As a first priority, minimize the length of the RF traces. Then, minimize bus length to reduce potential EMI issues related to the radiation of digital buses.
- All traces (Including low speed or DC traces) must couple with a reference plane (GND or power). High-speed buses should be referenced to the ground plane. If designers need to change the ground reference, some capacitors should be added and an adequate number of GND vias must be added in the area of transition. This facilitates a low-impedance path between the two GND layers for the return current.
- Trace routing should maintain a distance that is greater than  $3 \cdot W$  from the edge of the ground plane routing.
- Don't route power planes or traces in loops.
- Route the power traces through both the bypass capacitor and bulk capacitor before connecting to the module pin.
- Power planes should maintain a safe distance from the edge of the PCB. The distance must be sufficient to route a ground ring around the PCB, and the ground ring must then be stitched to other layers through vias.

## 3.5 Module footprint and paste mask

[Figure 8](#) shows the pin layout of NORA-W36 series modules. The proposed land pattern layout complements the pin layout of the module. Both Solder Mask Defined (SMD) and Non-Solder Mask Defined (NSMD) pins can be used with adherence to the following considerations:

- All pins should be Non-Solder Mask Defined (NSMD)
- To help with the dissipation of the heat generated by the module, GND pads must have good thermal bonding to PCB ground planes.



**Figure 8: NORA-W36 mechanical outline**

The suggested stencil layout for the NORA-W36 module should follow the copper pad layout, as shown in [Figure 8](#). The assembly house should determine the thickness of the solder paste stencil based on the entire host PCB, typically 100-120  $\mu\text{m}$ .

### 3.6 Thermal guidelines

The NORA-W36 series modules have been successfully tested at  $-40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ . A good grounding should be observed for temperature relief during high ambient temperature.

### 3.7 ESD guidelines

The immunity of devices integrating NORA-W36 modules to Electro-Static Discharge (ESD) is part of the Electro-Magnetic Compatibility (EMC) conformity, which is required for products bearing the CE marking, compliant with the R&TTE Directive (99/5/EC), the EMC Directive (89/336/EEC) and the Low Voltage Directive (73/23/EEC) issued by the Commission of the European Community.

Compliance with these directives implies conformity to the following European Norms for device ESD immunity: ESD testing standard *CENELEC EN 61000-4-2* and the radio equipment standards *ETSI EN 301 489-1*, *ETSI EN 301 489-7*, *ETSI EN 301 489-24*, the requirements of which are summarized in [Table 5](#).



The ESD immunity test is performed at the enclosure port, defined by *ETSI EN 301 489-1* as the physical boundary through which the electromagnetic field radiates. If the device implements an integral antenna, the enclosure port is seen as all insulating and conductive surfaces housing the device. If the device implements a removable antenna, the antenna port can be separated from the enclosure port. The antenna port includes the antenna element and its interconnecting cable surfaces.

The applicability of ESD immunity test to the whole device depends on the device classification, as defined by *ETSI EN 301 489-1*. Applicability of ESD immunity test to the related device ports or the related interconnecting cables to auxiliary equipment, depends on the device accessible interfaces and manufacturer requirements, as defined by the *ETSI EN 301 489-1*.

Contact discharges are performed at conductive surfaces, while air discharges are performed at insulating surfaces. Indirect contact discharges are performed on the measurement setup horizontal and vertical coupling planes as defined in the *CENELEC EN 61000-4-2*.

For the definition of integral antenna, removable antenna, antenna port, and device classification, see the *ETSI EN 301 489-1*. For contact and air discharges definitions, see *CENELEC EN 61000-4-2*.

Parameter	Min.	Typical	Max.	Unit	Remarks
ESD immunity. All exposed surfaces of the radio equipment and ancillary equipment in a representative configuration			8	kV	Indirect discharge according to IEC 61000-4-2
ESD sensitivity, tested for all pins except ANT and RSVD pins #11, #15, #33			2.0	kV	Human body model according to JEDEC JS001

**Table 5: Electro-Magnetic Compatibility ESD immunity requirements as defined by CENELEC EN 61000-4-2, ETSI EN 301 489-1, ETSI EN 301 489-7, ETSI EN 301 489-24**

NORA-W36 is manufactured with consideration to the specific standards for minimizing the occurrence of ESD events. The highly automated process complies with the IEC61340-5-1 (STM5.2-1999 Class M1 devices) standard. Consequently, the designer should implement proper measures to protect from ESD events on any pin that may be exposed to the end user.

Compliance with standard protection level specified in the EN61000-4-2 can be achieved by including the ESD protections in parallel to the line, close to areas accessible by the end user.

### 3.7.1 Schematic checklist

- ☐ All module pins have been properly numbered and designated in the schematic (including thermal pins).
- ☐ Power supply design complies with the specification.
- ☐ The power sequence has been properly implemented.
- ☐ Adequate bypassing has been included in front of each power pin.
- ☐ Each signal group is consistent with its own power rail supply or proper signal translation has been provided.
- ☐ Configuration pins, like **GPIO\_J9**, **SWITCH\_1** and **SWITCH\_2**, are properly set and can be controlled from host or be accessed through test points to allow boot into Bootloader.
- ☐ DBG\_TX should be available from host or accessed through test points to allow debug logging.
- ☐ Unused pins are properly terminated.
- ☐ A pi-filter is provided in front of each antenna for final matching (NORA-W361 only)
- ☐ Additional RF co-location filters have been considered in the design.

### 3.7.2 Layout checklist

- ☐ PCB stack-up and controlled impedance traces follow the recommendations given by the PCB manufacturer.
- ☐ All pins are properly connected, and the footprint follows u-blox pin design recommendations.
- ☐ Proper clearance has been provided between the RF and digital sections of the design.
- ☐ Proper isolation has been provided between antennas (RF co-location, diversity, or multi-antenna design).
- ☐ Bypass capacitors have been placed close to the module.
- ☐ Low impedance power path has been provided to the module.
- ☐ Controlled impedance traces have been properly implemented in the layout (both RF and digital) and the recommendations provided by the PCB manufacturer have been followed.
- ☐ 50  $\Omega$  RF traces and connectors follow the rules described in [RF connector design](#).
- ☐ Antenna design has been reviewed by the antenna manufacturer.
- ☐ Proper grounding has been provided to the module for the low impedance return path and heat sink.
- ☐ Reference plane skipping has been minimized for high frequency buses.
- ☐ All traces and planes are routed inside the area defined by the main ground plane.
- ☐ u-blox has reviewed and approved the PCB<sup>2</sup>.

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<sup>2</sup> Applicable only for end-products based on u-blox reference designs



## 4 Software

### 4.1 NORA-W36 u-connectXpress software

NORA-W36 stand-alone modules are delivered with embedded u-connectXpress software.

Typical examples of the applications and use cases supported by NORA-W36 series modules include:

- Connection of Bluetooth Low Energy (LE) sensors to the cloud over Wi-Fi
- Communication over serial, Bluetooth LE and Wi-Fi interfaces
- Device configuration using Bluetooth LE or Wi-Fi connected smartphones
- Secure cloud connection using TLS and MQTT protocols

Using industry-standard AT commands, this is the software that manages the combination of Wi-Fi connectivity and Bluetooth Low Energy. See [Figure 11](#) and [Figure 12](#) for examples.

For information about the features, capabilities, and use of u-connectXpress software, see the NORA-W36 u-connectXpress AT commands manual [\[12\]](#) and the NORA-W36 u-connectXpress user guide [\[13\]](#).

[Figure 9](#) shows the structure of the embedded u-connectXpress software supported in NORA-W36 standalone modules.

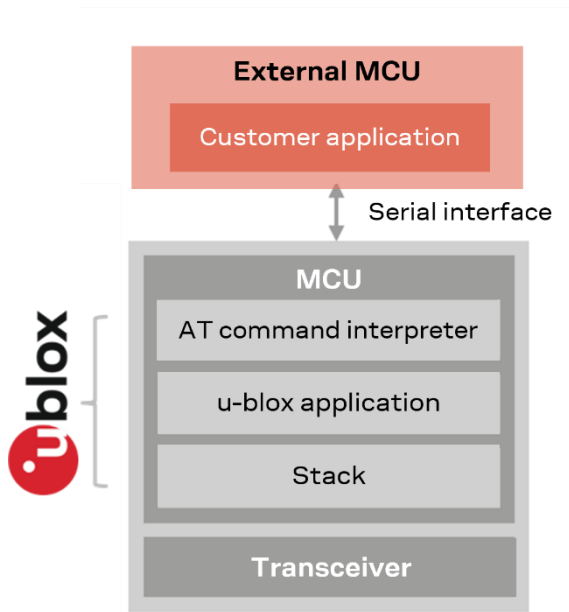


Figure 9: NORA-W36-connectXpress software structure

In Figure 10 the structure from Figure 9 are shown with more details, The software architecture of NORA-W36 includes all drivers and stacks for complete Bluetooth and Wi-Fi functionality.

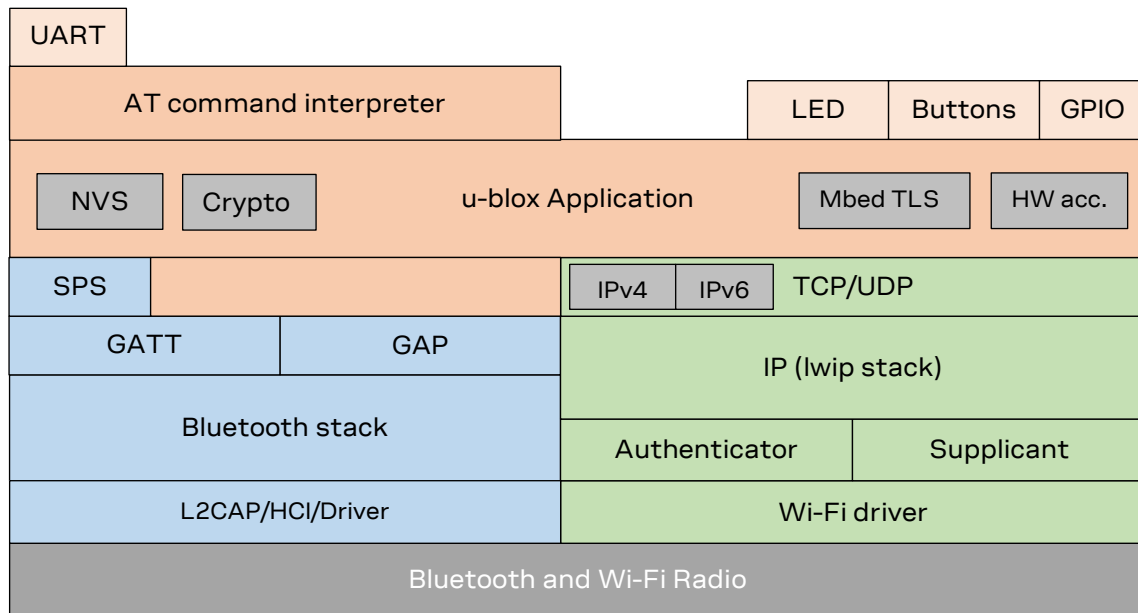


Figure 10: NORA-W36-connectXpress software architecture

Below shows an example of AT different commands and event types.

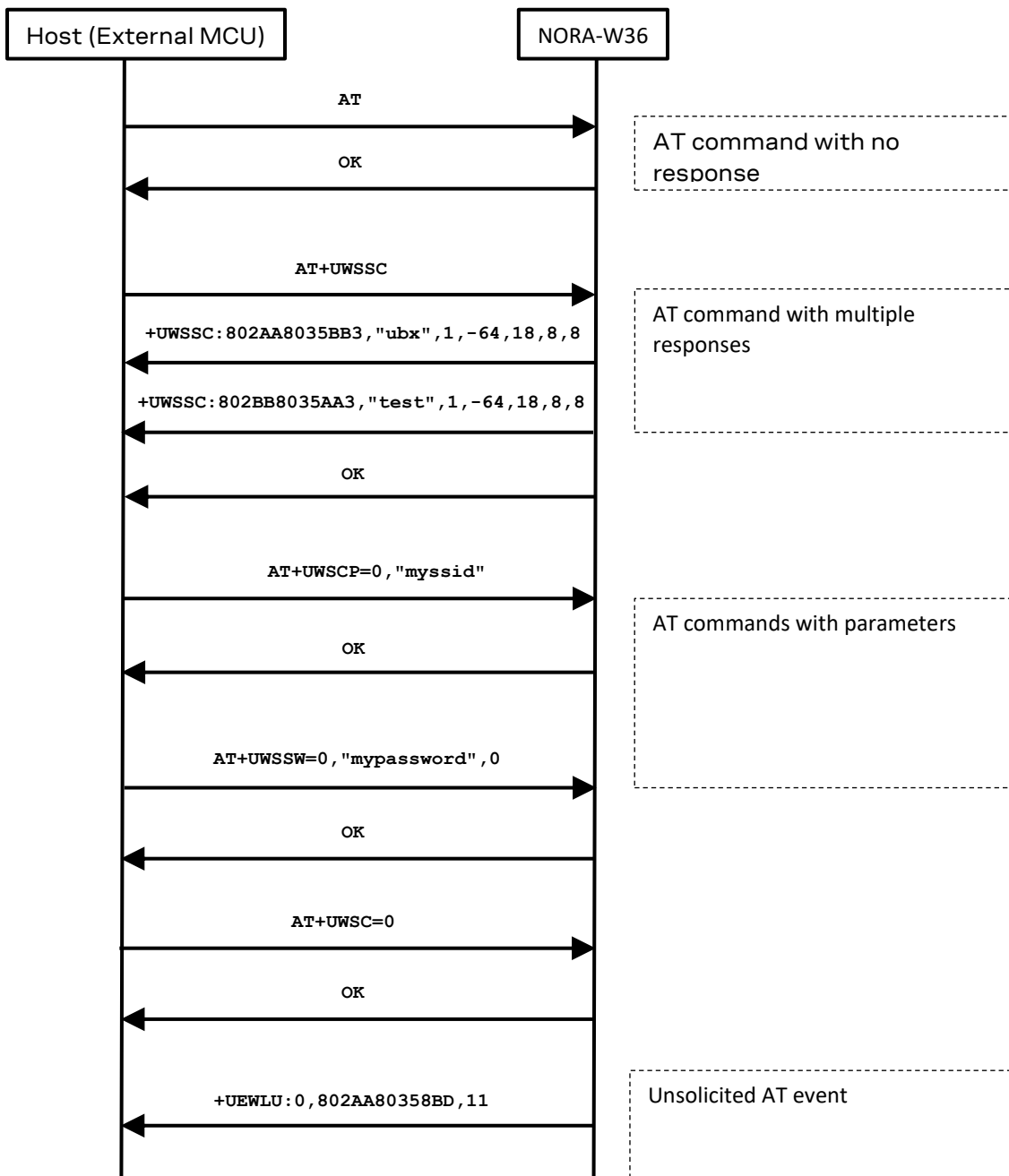


Figure 11: Example of AT commands and events

Below shows an example of AT commands to set up a TCP connection, and send and receive data using string mode.

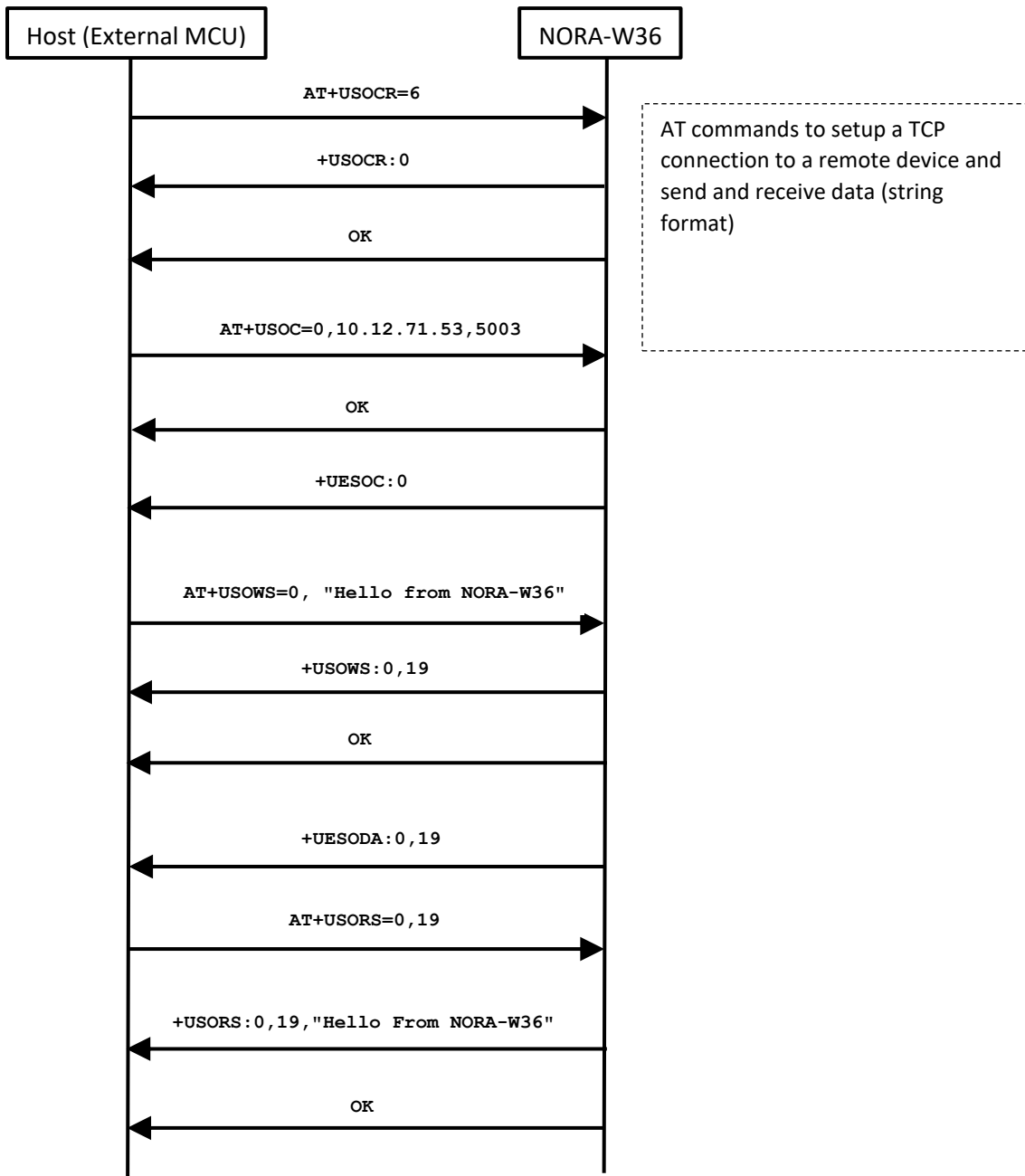



Figure 12: Example of AT command to setup TCP and send and receive data

## 4.2 Software update

NORA-W36 u-connectXpress software includes a bootloader for flashing the module over the UART interface. The file download uses standard XMODEM protocol. You can update the software using the u-blox s-center 2 [13] or using third-party Terminal software like TeraTerm.

u-connectXpress software can be downloaded at speeds of up to 3 Mbps over the UART interface. The XMODEM-1K mode is recommended for maximum download speed.

 Always use the latest software version to leverage new functionality in your application and benefit from bug fixes and security improvements. Download the latest software version at <http://www.u-blox.com> and [NORA-W36 series](#) product page.

Use s-center 2 [13] or third-party Terminal software like Tera Term to update the software.

### 4.2.1 Updating with s-center2

s-center 2 [13] client software provides a convenient tool with which to configure u-blox standalone modules. It runs on PCs running Windows 10 or later and is available for download here [13].

To flash the module using s-center2:

1. Start **s-center 2**
2. Select **your workspace** and **your device** like **NORA-W36**
3. Click on **Configure** and select the software binary file.
4. Click on **Start** to begin the software update.

### 4.2.2 Updating with Terminal

It is possible to start the XMODEM protocol used for file transfer with an AT command or using the bootloader.

#### Updating using AT command

1. Connect to the module using Tera Term, for example, and set the port to 115 200 baud rate, 8-bit data without parity, 1 stop bit, and no flow control.
2. Enter the AT command **AT+USYFWU=0,115200**. The module responds with **OK** and enters the bootloader.
3. When the bootloader displays “> cccc...” the module is ready to receive the software binary file.
4. Send the file using XMODEM protocol.
5. The module restarts with **+STARTUP** when the file transfer is complete.

#### Updating using the bootloader

1. Enter the bootloader by either:
  - a) Entering AT command **AT+USYFWU=1,115200**
  - b) Setting GPIO pins, **SWITCH\_1** and **SWITCH\_2**, low during power up or module reset. The bootloader prompt “>” is displayed in the Terminal when the bootloader mode has started, as shown in [Figure 13](#). The bootloader times out after 10 seconds if no command is sent.
2. Enter the command “**x**” to start XMODEM and set the bootloader in file transfer mode.
3. When the bootloader displays “> cccc...” the module is ready to receive the software binary file.
4. Send the file using XMODEM protocol.
5. An OK response indicates a successful file transfer.
6. Enter command “**q**” to restart the module.

```

NORA-W36 bootloader: 1.0.1-001
u-blox
> ?
?                                     Help
r <baud_rate> [ <flowctrl>]]         Set baud rate and flow control on/off
q                                     SoC reset
x                                     Start Xmodem Rx
v                                     Get version information
OK
> x
CCCCCCCCCCCCC                       // Terminal sends the file using XMODEM protocol
OK
> q

+STARTUP

```

**Figure 13: Software download using XMODEM**

## 4.3 Regulatory domain and output power

NORA-W36 use World mode at default regulatory domain, with limited supported channels accepted in the world. In order to use more channels, the regulatory domain must be changed by the AT command **AT+UWRD=<reg\_domain>**. The codes in [Table 6](#) must be used for the appropriate regulatory domain to limit Wi-Fi channel selection and output power. The OEM integrator must make sure the right regulatory domain is used in the country NORA-W36 is operating to maintain regulatory compliance.

It is not possible to change the output power manually on NORA-W36, it is defined by the different regulatory domains.

Number	Regulatory domain	Supported 2,4 GHz Channels	Supported 5 GHz Channels
0	World (Default)	1-11	36, 40, 44, 48 52, 56, 60, 64
1	ETSI	1-13	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 120, 124, 128, 132, 136, 140 149, 153, 157, 161, 165
2	FCC	1-11	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 120, 124, 128, 132, 136, 140 149, 153, 157, 161, 165
3	IC/ISED	1-11	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 132, 136, 140, 144 149, 153, 157, 161, 165
4	NZ/BR*	1-13	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 120, 124, 128, 132, 136, 140, 144 149, 153, 157, 161, 165
5	MKK/Japan*	1-14	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 120, 124, 128, 132, 136, 140, 144

Number	Regulatory domain	Supported 2,4 GHz Channels	Supported 5 GHz Channels
6	NCC/Taiwan*	1-11	52, 56, 60, 64 100, 104, 108, 112, 116, 132, 136, 140
7	ACMA/AU*	1-13	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 132, 136, 140, 144 149, 153, 157, 161, 165
8	KCC*	1-13	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 120, 124, 128, 132, 136, 140, 144 149, 153, 157, 161, 165
8	SA/South Africa*	1-13	36, 40, 44, 48 52, 56, 60, 64 100, 104, 108, 112, 116, 120, 124, 128, 132, 136, 140

\*NOTE: Certification pending. DO NOT USE without certifying the end product

Table 6: Approved regulatory domains

## 4.4 Wi-Fi MAC and Bluetooth device addresses and other production data

NORA-W36 series modules are assigned a block of four MAC addresses. The first Wi-Fi MAC address (base address) is encoded in the Data Matrix on the label. For data matrix details, see the NORA-W36 datasheet [2] and product labelling requirements for each region. See [Regulatory compliance](#).

MAC address	Assignment	AT command
Base address	Wi-Fi station	AT+USYLA=1
Base address + 1	Wi-Fi access point	AT+USYLA=2
Base address + 2	Bluetooth Low Energy device address	AT+USYLA=0
Base address + 3	Unused	

Figure 14: MAC addresses

It is also possible to change Address by adding the address to the command, for example:  
**AT+USYLA=1,112233445566**

The base MAC address and calibration data are written during the production of NORA-W3.

## 5 Handling and soldering

**⚠** NORA-W36 series modules are Electrostatic Sensitive Devices that demand the observance of special handling precautions against static damage. Failure to observe these precautions can result in severe damage to the product.



### 5.1 ESD handling precautions

As the risk of electrostatic discharge in the RF transceivers and patch antennas of the module is of particular concern, standard ESD safety practices are prerequisite. See also [Figure 15](#).

Consider also:

- When connecting test equipment or any other electronics to the module (as a standalone or PCB-mounted device), the first point of contact must always be to local GND.
- Before mounting an antenna patch, connect the device to ground.
- When handling the RF pin, don't touch any charged capacitors. Be especially careful when handling materials like patch antennas (~10 pF), coaxial cables (~50-80 pF/m), soldering irons, or any other materials that can develop charges.
- To prevent electrostatic discharge through the RF input, don't touch any exposed antenna area. If there is any risk of the exposed antenna being touched in an unprotected ESD work area, be sure to implement proper ESD protection measures in the design.
- When soldering RF connectors and patch antennas to the RF pin on the receiver, be sure to use an ESD-safe soldering iron (tip).

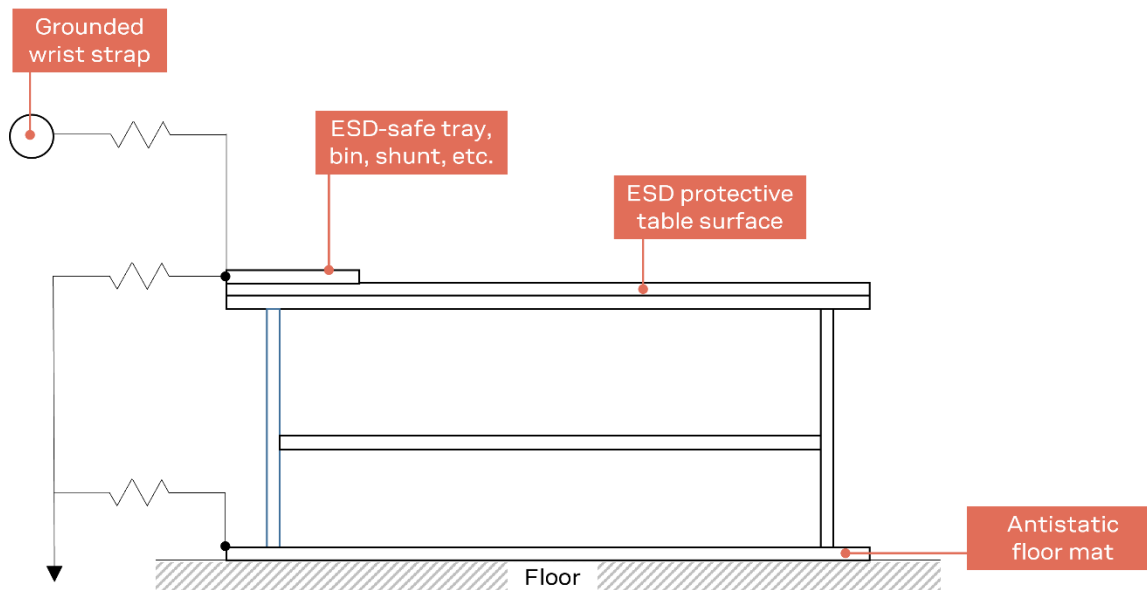


Figure 15: Standard workstation setup for safe handling of ESD-sensitive devices

### 5.2 Packaging, shipping, storage, and moisture preconditioning

For information pertaining to reels, tapes or trays, moisture sensitivity levels (MSL), shipment and storage, as well as drying for preconditioning, refer to the NORA-W36 series data sheet [\[2\]](#) and Packaging information reference guide [\[1\]](#).



### 5.3 Reflow soldering process

NORA-W36 series modules are surface mounted devices supplied in a Land Grid Array (LGA) package with gold-plated solder lands. The modules are manufactured in a lead-free process with lead-free soldering paste.

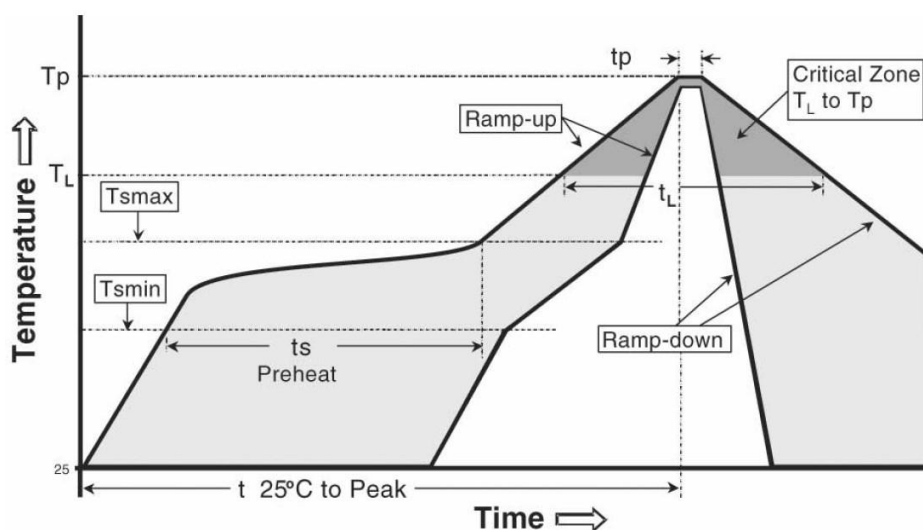
The thickness of solder resist between the host PCB top side and the bottom side of the NORA-W36 series module must be considered for the soldering process.

NORA-W36 modules are compatible with the industrial reflow profile for common SAC type RoHS solders. No-clean soldering paste is strongly recommended. The reflow profile is dependent on the thermal mass over the entire area of the fully populated host PCB, the heat transfer efficiency of the oven, and the type of solder paste that is used. The optimal soldering profile that is used must be trimmed for each case depending on the specific soldering process and PCB layout.

The target parameter values shown in [Table 7](#) are only general guidelines for a Pb-free process. The given values are tentative and subject to change. For further information, see also the JEDEC J-STD-020C standard [\[3\]](#).

Process parameter		Unit	Target
Pre-heat	Ramp up rate to $T_{SMIN}$	K/s	3
	$T_{SMIN}$	°C	150
	$T_{SMAX}$	°C	200
	$t_s$ (from +25 °C)	s	150
	$t_s$ (Pre-heat)	s	60 to 120
Peak	$T_L$	°C	217
	$t_L$ (time above $T_L$ )	s	40 to 60
	$T_P$ (absolute max)	°C	245
Cooling	Ramp-down from $T_L$	K/s	4
	Allowed soldering cycles	-	1

**Table 7: Recommended reflow profile**



**Figure 16: Reflow profile**

Lower value of  $T_P$  and slower ramp down rate (2–3 °C/sec) is preferred.



After reflow soldering, optical inspection of the modules is recommended to verify proper alignment.

### 5.3.1 Cleaning

Cleaning the modules is not recommended. Residues underneath the modules cannot be easily removed with a washing process.

- Cleaning with water will lead to capillary effects where water is absorbed in the gap between the baseboard and the module. The combination of residues of soldering flux and encapsulated water leads to short circuits or resistor-like interconnections between neighboring pins. Water will also damage the sticker and the ink-jet printed text.
- Cleaning with alcohol or other organic solvents can result in soldering flux residues flooding into the housing, areas that are not accessible for post-wash inspections. The solvent will also damage the label and the ink-jet printed text.
- Ultrasonic cleaning will permanently damage the module and the crystal oscillators in particular.

For best results use a “no-clean” soldering paste and circumvent the need for a cleaning stage after the soldering process.


### 5.3.2 Other notes

- Only a single-reflow soldering process<sup>3</sup> is allowed for boards with a module populated on it.
- Boards with combined through-hole technology (THT) components and surface-mount technology (SMT) devices may require wave soldering to solder the THT components. Only a single wave-soldering process is allowed for boards populated with the modules. Miniature Wave Selective Solder processes are preferred over traditional wave soldering processes.
- Hand-soldering is not recommended.
- Rework is not recommended.
- Conformal coating can affect the performance of the module, which means that it is important to prevent the liquid from flowing into the module. The RF shields don't provide protection for the module from coating liquids with low viscosity; therefore, care is required while applying the coating. Conformal Coating of the module will void the warranty.
- Grounding metal covers: Attempts to improve grounding by soldering ground cables, wick, or other forms of metal strips directly onto the EMI covers is done so at the customer's own risk and will void the module warranty. The numerous ground pins are adequate to provide optimal immunity to interferences.
- The modules contain components which are sensitive to Ultrasonic Waves. Use of any Ultrasonic Processes (cleaning, welding, etc.) may damage the module. The use of ultrasonic processes during the integration of the module into an end product will void the warranty.

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<sup>3</sup> Two reflow soldering processes are planned to be supported.


## 6 Regulatory compliance

 All approvals are currently pending.

### 6.1 General requirements

NORA-W36 series modules are designed to comply with the regulatory demands of Federal Communications Commission (FCC), Innovation, Science, and Economic Development Canada (ISED) and the CE mark. This chapter contains instructions on the process needed for an integrator when including the NORA-W36 module into an end-product.

- Any deviation from the process described may cause the NORA-W36 series module not to comply with the regulatory authorizations of the module and thus void the user's authority to operate the equipment.
- Any changes to hardware, hosts or co-location configuration may require new radiated emission and SAR evaluation and/or testing.
- The regulatory compliance of NORA-W36 series module does not exempt the end-product from being evaluated against applicable regulatory demands. For example, FCC Part 15B criteria for unintentional radiators [\[4\]](#).
- The end-product manufacturer must follow all the engineering and operating guidelines as specified by the grantee (u-blox).
- The NORA-W36 is for OEM integrators only.
- Only authorized antenna(s) may be used. Refer to the list of [Pre-approved antenna list](#). In the end-product, the NORA-W36 series module must be installed in such a way that only authorized antennas can be used.
- For end products using the NORA-W361, the end-product must use the specified antenna trace reference design, as described in the [NORA-W361 U.FL reference design](#).
- Any notification to the end user about how to install or remove the integrated radio module is NOT allowed.
- Electromagnetic interference compatibility (EMI/EMC) and spurious emissions tests are required for end-products targeted for most world regions.
- RF output power is controlled by the region code

 If these conditions cannot be met or any of the operating instructions are violated, the u-blox regulatory authorization will be considered invalid. Under these circumstances, the integrator is responsible to re-evaluate the end-product including the NORA-W36 series module and obtain their own regulatory authorization, or u-blox may be able to support updates of the u-blox regulatory authorization. See also [Antenna requirements](#).

## 6.2 EU regulatory compliance

NORA-W36 series modules comply with the essential requirements and other relevant provisions of Radio Equipment Directive (RED) 2014/53/EU.

For information about the regulatory compliance of NORA-W36 series modules against requirements and provisions in the European Union, see the NORA-W3 Declaration of Conformity [10].



### 6.2.1 End-product regulatory compliance

#### 6.2.1.1 Safety standard

To fulfill the safety standard EN 62368-1 [7], the NORA-W36 module must be supplied with a Class-2 Limited Power Source.

#### 6.2.1.2 ETSI Equipment classes

In accordance with Article 1 of Commission Decision 2000/299/EC<sup>4</sup>, NORA-W36 is defined as either Class-1 or Class-2 radio equipment, the end-product integrating NORA-W36 inherits the equipment class of the module.

-  Guidance on end product marking, according to the RED can be found at: <http://ec.europa.eu/>
-  The restrictions while operating the NORA-W36 in Wi-Fi mode in the European countries are shown in section “European Union regulatory compliance” of the NORA-W36 data sheet [2].

The EIRP of the NORA-W36 module must not exceed the limits of the regulatory domain that the module operates in. Depending on the host platform’s implementation and antenna gain, integrators have to limit the maximum output power of the module through the application software. Refer to the NORA-W30 data sheet [2] and [Approved antennas](#) for the module’s approved antennas list and corresponding maximum transmit power levels.


### 6.2.2 Compliance with the RoHS directive

NORA-W36 series modules comply with the Directive 2011/65/EU (EU RoHS 2) and its amendment Directive (EU) 2015/863 (EU RoHS 3).

## 6.3 Great Britain regulatory compliance

For information about the regulatory compliance of NORA-W36 series modules against requirements and provisions in Great Britain, see also the NORA-W3 UKCA Declaration of Conformity [11].

### 6.3.1 UK Conformity Assessed (UKCA)

-  The United Kingdom is made up of the Great Britain (including England, Scotland, and Wales) and the Northern Ireland. Northern Ireland continues to accept the CE marking. The following notice is applicable to Great Britain only.


NORA-W36 series modules have been evaluated against the essential requirements of the Radio Equipment Regulations 2017 (SI 2017 No. 1206, as amended by SI 2019 No. 696).

Guidance about using the UKCA marking: <https://www.gov.uk/guidance/using-the-ukca-marking>.

<sup>4</sup> 2000/299/EC: Commission Decision of 6 April 2000 establishing the initial classification of radio equipment and telecommunications terminal equipment and associated identifiers.

## 6.4 FCC/ISED End-product regulatory compliance

u-blox represents that the modular transmitter fulfills the FCC/ISED regulations when operating in authorized modes on any host product given that the integrator follows the instructions as described in this document. Accordingly, the host product manufacturer acknowledges that all host products referring to the FCC ID or ISED certification number of the modular transmitter and placed on the market by the host product manufacturer need to fulfil all of the requirements mentioned below. Non-compliance with these requirements may result in revocation of the FCC approval and removal of the host products from the market. These requirements correspond to questions featured in the FCC guidance for software security requirements for U-NII devices, FCC OET KDB 594280 D02 [9].

 The modular transmitter approval of NORA-W36, or any other radio module, does not exempt the end product from being evaluated against applicable regulatory demands.

The evaluation of the end product shall be performed with the NORA-W36 module installed and operating in a way that reflects the intended end product use case. The upper frequency measurement range of the end product evaluation is the 5<sup>th</sup> harmonic of 5.8 GHz as described in KDB 996369 D04.

The following requirements apply to all products that integrate a radio module:

- Subpart B – UNINTENTIONAL RADIATORS  
To verify that the composite device of host and module comply with the requirements of FCC part 15B, the integrator shall perform sufficient measurements using ANSI 63.4-2014.
- Subpart C – INTENTIONAL RADIATORS  
It is required that the integrator carries out sufficient verification measurements using ANSI 63.10-2013 to validate that the fundamental and out of band emissions of the transmitter part of the composite device complies with the requirements of FCC part 15C.

When the items listed above are fulfilled, the end product manufacturer can use the authorization procedures as mentioned in Table 1 of 47 CFR Part 15.101, before marketing the end product. This means the customer has to either market the end product under a Suppliers Declaration of Conformity (SdoC) or to certify the product using an accredited test lab.


The description is a subset of the information found in applicable publications of FCC Office of Engineering and Technology (OET) Knowledge Database (KDB). We recommend the integrator to read the complete document of the referenced OET KDB's.

- KDB 178919 D01 Permissive Change Policy
- KDB 447498 D01 General RF Exposure Guidance
- KDB 594280 D01 Configuration Control
- KDB 594280 D02 U-NII Device Security
- KDB 784748 D01 Labelling Part 15 18 Guidelines
- KDB 996369 D01 Module certification Guide
- KDB 996369 D02 Module Q&A
- KDB 996369 D04 Module Integration Guide

### 6.4.1 United States compliance statement (FCC)

NORA-W36 series modules have modular approval and comply with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

1. This device may not cause harmful interference, and
2. This device must accept any interference received, including interference that may cause undesired operation.

 Any changes or modifications NOT explicitly APPROVED by u-blox could cause the NORA-W36 series module to cease to comply with FCC rules part 15 thus void the user's authority to operate the equipment.

The internal / external antenna(s) used for this module must provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

[Table 8](#) shows the FCC IDs allocated to NORA-W36 series modules.

Model	FCC ID
NORA-W360	XPYNORAW3
NORA-W361	XPYNORAW3
NORA-W366	XPYNORAW3

**Table 8: FCC IDs for different variants of NORA-W36 series modules**

For FCC end-product labeling requirements, see [End product labeling requirements](#).

### 6.4.2 Canada compliance statement (ISED)


NORA-W36 series modules are certified for use in accordance with Innovation, Science and Economic Development Canada (ISED) Radio Standards Specification (RSS) RSS-247 Issue 2 and RSS-Gen. [Table 9](#) shows the ISED certification IDs allocated to NORA-W36 series modules.

Model	ISED certification ID
NORA-W360	8595A-NORAW3
NORA-W361	8595A-NORAW3
NORA-W366	8595A-NORAW3

**Table 9: ISED IDs for different variants of NORA-W36 series modules**

NORA-W36 complies with ISED (Innovation, Science and Economic Development Canada)<sup>5</sup> license-exempt RSS(s). Operation is subject to the following two conditions:

1. This device may not cause interference, and
2. This device must accept any interference, including interference that may cause undesired operation of the device.



 Any notification to the end user of installation or removal instructions about the integrated radio module is NOT allowed. Unauthorized modification could void authority to use this equipment.

This equipment complies with ISED RSS-102 radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20 cm between the radiator and your body.

This radio transmitter IC: 8595A-NORAW3 has been approved by ISED to operate with the antenna types listed in the [Approved antennas](#) with the maximum permissible gain indicated. Antenna types

<sup>5</sup> Formerly known as IC (Industry Canada).

not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.



-  Operation in the band 5150–5250 MHz is only for indoor use to reduce the potential for harmful interference to co-channel mobile satellite systems.
-  Operation in the 5600-5650 MHz band is not allowed in Canada. High-power radars are allocated as primary users (i.e., priority users) of the bands 5250-5350 MHz and 5650-5850 MHz and that these radars could cause interference and/or damage to LE-LAN devices.

Le présent appareil est conforme aux CNR d'ISED applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- (1) l'appareil ne doit pas produire de brouillage, et
- (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.


Cet équipement est conforme aux limites d'exposition de rayonnement d'ISED RSS-102 déterminées pour un environnement non contrôlé. Cet équipement devrait être installé et actionné avec la distance minimum 20 cm entre le radiateur et votre corps.

Cet émetteur radio, IC : 8595A-NORAW3 été approuvé par ISED pour fonctionner avec les types d'antenne énumérés ci-dessous avec le gain maximum autorisé et l'impédance nécessaire pour chaque type d'antenne indiqué. Les types d'antennes non inclus dans la [Approved antennas](#) des antennes approuvées et ayant un gain supérieur au gain maximum indiqué pour ce type sont strictement interdits pour une utilisation avec cet appareil.

-  Le dispositif de fonctionnement dans la bande 5150-5250 MHz est réservé à une utilisation en intérieur pour réduire le risque d'interférences nuisibles à la co-canal systèmes mobiles par satellite
-  Opération dans la bande 5600-5650 MHz n'est pas autorisée au Canada. Haute puissance radars sont désignés comme utilisateurs principaux (c.-à utilisateurs prioritaires) des bandes 5250-5350 MHz et 5650-5850 MHz et que ces radars pourraient causer des interférences et / ou des dommages à dispositifs LAN-EL.

The internal / external antenna(s) used for this module must provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.


For ISED end-product labeling requirements, see [End product labeling requirements](#).

-  The approval type for all NORA-W36 series variants is a single modular approval. Due to ISED Modular Approval Requirements (Source: RSP-100 Issue 10), any application which includes the module must be approved by the module manufacturer (u-blox). The application manufacturer must provide design data for the review procedure.

### 6.4.3 Referring to the u-blox FCC/ISED certification ID

If the [General requirements](#), [FCC/ISED End-product regulatory compliance](#) and all [Antenna requirements](#) are met, the u-blox modular FCC/ISED regulatory authorization is valid and the end-product may refer to the u-blox FCC ID and ISED certification number. U-blox may be able to support updates to the u-blox regulatory authorization by adding new antennas to the u-blox authorization for example. See also [Antenna requirements](#).



 To use the u-blox FCC / ISED grant and refer to the u-blox FCC ID / ISED certification ID, the integrator must confirm with u-blox that the all requirements associated with the software configuration and [Software configuration and control](#) are fulfilled.

#### 6.4.4 Obtaining own FCC/ISED certification ID


Integrators that don't want to refer to the u-blox FCC/ISED certification ID, or who don't fulfil all requirements to do so, may instead obtain their own certification. With their own certification, the integrator has full control of the grant to make changes.

Integrators who want to base their own certification on the u-blox certification can do so via a process called "Change in ID" (FCC) / "Multiple listing" (ISED). With this, the integrator becomes the grantee of a copy of the u-blox FCC/ISED certification. u-blox will support with an approval letter that shall be filed as a Cover Letter exhibit with the application.

 It is the responsibility of the integrator to comply with any upcoming regulatory requirements.

#### 6.4.5 Antenna requirements

In addition to the general requirement to use only authorized antennas, the u-blox grant also requires a separation distance of at least 20 cm from the antenna(s) to all persons. The antenna(s) must not be co-located with any other antenna or transmitter (simultaneous transmission) as well. If this cannot be met, a Permissive Change as described below must be made to the grant.

 To support verification activities that may be required by certification laboratories, customers applying for Class-II Permissive changes must implement the setup described in [Software configuration and control](#).

##### 6.4.5.1 Separation distance

If the required separation distance of 20 cm cannot be fulfilled, a SAR evaluation must be performed. This consists of additional calculations and/or measurements. The result must be added to the grant file as a Class II Permissive Change.


##### 6.4.5.2 Co-location (simultaneous transmission)

If the module is to be co-located with another transmitter, additional measurements for simultaneous transmission are required. The results must be added to the grant file as a Class II Permissive Change.

##### 6.4.5.3 Adding a new antenna for authorization

If the authorized antennas and/or antenna trace design cannot be used, the new antenna and/or antenna trace designs must be added to the grant file. This is done by a Class I Permissive Change or a Class II Permissive Change, depending on the specific antenna and antenna trace design.

- Antennas of the same type and with less or same gain as those included in [Pre-approved antenna list](#) can be added under a Class I Permissive Change.
- Antenna trace designs deviating from the u-blox reference design and new antenna types are added under a Class II Permissive Change.
- For 5 GHz modules, the combined minimum gain of antenna trace and antenna must be greater than 0 dBi to comply with DFS testing requirements.

 Integrators intending to refer to the u-blox FCC ID / ISED certification ID must [contact](#) their local support team to discuss the Permissive Change Process. Class II Permissive Changes are subject to NRE costs.



## 6.4.6 Software configuration and control


 “Modular transmitter” hereafter refers to NORA-W36 series (FCC ID XPYNORAW3).


As the end product must comply with the requirements addressed by the OET KDB 594280 [8], the host product integrating the NORA-W36 must comply with the following requirements:

- Upon request from u-blox, the host product manufacturer will provide all of the necessary information and documentation to demonstrate how the requirements listed below are met.
- The host product manufacturer will not modify the modular transmitter hardware.
- The configuration of the modular transmitter when installed into the host-product must be within the authorization of the modular transmitter at all times and cannot be changed to include unauthorized modes of operation through accessible interfaces of the host-product.

The Wi-Fi transmit output power limits must be followed. In particular, the modular transmitter installed in the host-product will not have the capability to operate on the operating channels/frequencies referred to in the section(s) below, namely the following channels: 12 (2467 MHz), 13 (2472 MHz)). The channels 120 (5600 MHz), 124 (5620 MHz), and 128 (5640 MHz) are allowed to be used in the US in client mode only. NORA-W36 use is certified as supporting DFS client functionality.

- The host product uses only authorized firmware images provided by u-blox and/or by the manufacturer of the RF chipset used inside the modular transmitter.
- The configuration of the modular transmitter must always follow the requirements specified in [Operating frequencies](#) and cannot be changed to include unauthorized modes of operation through accessible interfaces of the host product.
- The modular transmitter must when installed into the host product have a regional setting that is compliant with authorized US modes and the host product is protected from being modified by third parties to configure unauthorized modes of operation for the modular transmitter, including the country code.
- The host product into which the modular transmitter is installed does not provide any interface for the installer to enter configuration parameters into the end product that exceeds those authorized.
- The host product into which the modular transmitter is installed does not provide any interface to third parties to upload any unauthorized firmware images into the modular transmitter and prevents third parties from making unauthorized changes to all or parts of the modular transmitter device driver software and configuration.

 OET KDB 594280 D01 [8] lists the topics that must be addressed to ensure that the end-product specific host meets the Configuration Control requirements.

 OET KDB 594280 D02 [9] lists the topics that must be addressed to ensure that the end-product specific host meets the Software Security Requirements for U-NII Devices.

## 6.4.7 Operating frequencies

NORA-W36 802.11b/g/n operation outside the 2412–2462 MHz band is prohibited in the US and Canada and 802.11a/n operation in the 5600–5650 MHz band is prohibited in Canada. Configuration of the module to operate on channels 12–13 and 120–128 must be prevented accordingly.


The channels allowed while operating under the definition of a master or client device<sup>6</sup> are described in [Table 10](#).

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<sup>6</sup> 47 CFR §15.202

Channel number	Channel center frequency [MHz]	Master device	Client device	Remarks
1 – 11	2412 – 2462	Yes	Yes	
12 – 13	2467 – 2472	No	No	
36 – 48	5180 – 5240	Yes	Yes	Canada (ISED): Devices are restricted to indoor operation only and the end product must be labelled accordingly.
52 – 64	5260 – 5320	No	Yes	
100 – 116	5500 – 5580	No	Yes	
120 – 128	5600 – 5640	No	Yes	USA (FCC): Client device operation allowed under KDB 905462
132 – 144	5660 – 5720	No	Yes	
149 – 165	5745 – 5825	No	Yes	

**Table 10: Allowed channel usage under FCC/ISED regulation**

 15.407 (j) Operator Filing Requirement:  
Before deploying an aggregate total of more than one thousand outdoor access points within the 5.15–5.25 GHz band, parties must submit a letter to the Commission acknowledging that, should harmful interference to licensed services in this band occur, they will be required to take corrective action. Corrective actions may include reducing power, turning off devices, changing frequency bands, and/or further reducing power radiated in the vertical direction. This material shall be submitted to Laboratory Division, Office of Engineering and Technology, Federal Communications Commission, 7435 Oakland Mills Road, Columbia, MD 21046. Attn: U-NII Coordination, or via Web site at <https://www.fcc.gov/labhelp> with the subject line: “U-NII-1 Filing”.

## 6.4.8 End product labeling requirements

For an end-product using the NORA-W36, there must be a label containing, at least, the following information:

This device contains  
FCC ID: XPYNORAW3  
IC: 8595A-NORAW3

“XPY” represents the FCC “Grantee Code” for u-blox AG, this code may consist of Arabic numerals, capital letters, or other characters, the format for this code will be specified by the Commission’s Office of Engineering and Technology<sup>7</sup>. “8595A” is the Company Number for u-blox AG registered at ISED. “NORAW3” is the Unique Product Number decided by the grant owner.

The label must be affixed to an exterior surface of the end product such that it will be visible upon inspection in compliance with the modular labeling requirements of OET KDB 784748. The host user manual must also contain clear instructions on how end users can find and/or access the FCC ID of the end product.

<sup>7</sup> 47 CFR 2.926

## FCC end product labeling

In accordance with 47 CFR § 15.19, the end product shall bear the following statement in a conspicuous location on the device:

Contains FCC ID: XPYNORAW3

This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions:

1. This device may not cause harmful interference, and
2. This device must accept any interference received, including interference that may cause undesired operation.

The following statement must be included in the end-user manual or guide:

Changes or modifications to this unit not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

## ISED end product labeling

The end product shall bear the following statement in both English and French in a conspicuous location on the device:

Contains transmitter module IC: 8595A-NORAW3

This device contains licence-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's licence-exempt RSS(s). Operation is subject to the following two conditions:

1. This device may not cause interference.
2. This device must accept any interference, including interference that may cause undesired operation of the device.

Contient le module émetteur IC: 8595A-NORAW3

L'émetteur/récepteur exempt de licence contenu dans le présent appareil est conforme aux CNR d'Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

1. L'appareil ne doit pas produire de brouillage;
2. L'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Labels of end products capable of operating within the band 5150–5250 MHz shall also include:

For indoor use only

Pour usage intérieur seulement

When the device is so small or for such use that it is not practicable to place the statements above on it, the information shall be placed in a prominent location in the instruction manual or pamphlet supplied to the user or, alternatively, shall be placed on the container in which the device is marketed. However, the FCC/ISED ID label must be displayed on the device as described above.

In cases where the final product will be installed in locations where the end-consumer is unable to see the FCC/ISED ID and/or this statement, the FCC/ISED ID and the statement shall also be included in the end-product manual.

## 6.5 Japan radio equipment compliance (pending)

Use of 2.4 GHz channel 14 is supported for Japanese markets.

### 6.5.1 Compliance statement

NORA-W36 series modules comply with the Japanese Technical Regulation Conformity Certification of Specified Radio Equipment (ordinance of MPT N°. 37, 1981), Article 2, Paragraph 1:

- Item 19 "2.4 GHz band wide band low power data communication system".
- Item 19-3 "Low power data communications system in the 5.2/5.3 GHz band"
- Item 19-3-2 "Low power data communications system in the 5.6 GHz band"

The NORA-W36 series module is restricted on the Japanese market to be used indoors only if the product is operating in the 5.2/5.3 GHz band.

Table 11 shows the Giteki certification IDs allocated to NORA-W36 series modules.

Model	Giteki ID
NORA-W360	MIC ID:  xxx-xxxxxx, MIC ID:  yyyyyyyyyy
NORA-W361	MIC ID:  xxx-xxxxxx, MIC ID:  yyyyyyyyyy
NORA-W366	MIC ID:  xxx-xxxxxx, MIC ID:  yyyyyyyyyy

Table 11: Giteki IDs for different variants of NORA-W36 series modules

### 6.5.2 End product labelling requirement

End products based on NORA-W36 series modules and targeted for distribution in Japan must be affixed with a label with the "Giteki" marking, as shown in Figure 17. The "Indoor use only" information translated into Japanese below is mandatory if the product is operating in the 5.2/5.3 GHz band. The product marking must be visible for inspection.



Figure 17: Giteki and marks with the NORA-W36 MIC certification numbers

### 6.5.3 End product user manual requirement

As the MIC ID is not included on the NORA-W36 marking, the end product manufacturer must include a copy of the NORA-W36 Japan Radio Certificate in the end product technical documentation.

## 6.6 KCC South Korea compliance (pending)

NORA-W36 series modules are certified by the Korea Communications Commission (KCC).

End products based on NORA-W36 series modules and targeted for distribution in South Korea must carry labels containing the KCC logo and certification number, as shown below. This information must also be included in the product user manuals.

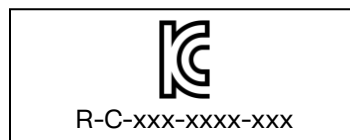


Figure 18: Sample label of an end product that includes NORA-W36

The height of the KCC logo must be at least 5 mm.

## 6.7 NCC Taiwan compliance

### 6.7.1 Taiwan NCC warning statement

[警語內容]

取得審驗證明之低功率射頻器材，非經核准，公司、商號或使用者均不得擅自變更頻率、加大功率或變更原設計之特性及功能。

低功率射頻器材之使用不得影響飛航安全及干擾合法通信；經發現有干擾現象時，應立即停用，並改善至無干擾時方得繼續使用。前述合法通信，指依電信管理法規定作業之無線電通信。低功率射頻器材須忍受合法通信或工業、科學及醫療用電波輻射性電機設備之干擾。

應避免影響附近雷達系統之操作。

系統廠商應於平台上標示「本產品內含射頻模組：CCXXXYYyyyZzW」字樣

Statement translation:

[Warning content]

- Without permission granted by the NCC, any company, enterprise, or user is not allowed to change frequency, enhance transmitting power, or alter original characteristic as well as performance to an approved low power radio-frequency device.
- The low power radio-frequency devices shall not influence aircraft security and interfere legal communications; If any interference is found or suspected, the user shall immediately cease operating the equipment until the interference has been prevented. The said legal communications means radio communications is operated in compliance with the Telecommunications Act. The low power radio-frequency devices must accept interference from legal communications or ISM radio wave radiated devices.
- When operating this device, avoid affect the operation of nearby radar systems

### 6.7.2 Labeling requirements for end product

End products based on NORA-W30 series modules and targeted for distribution in Taiwan must carry labels with the textual and graphical elements shown below.

For NORA-W300:

**Contains Transmitter Module**

內含發射器模組:  CCXXXYYyyyZzW

Figure 19: Labeling for end-products containing NORA-W360

For NORA-W301:

**Contains Transmitter Module**

內含發射器模組:  CCXXXYYyyyZzW

Figure 20: Labeling for end-products containing NORA-W361

For NORA-W306:

**Contains Transmitter Module**

內含發射器模組:  CCXXXYYyyyZzW

Figure 21: Labeling for end-products containing NORA-W366

Other wording can be used, but only if the meaning of original messaging remains unchanged. The label must be physically attached to the product and made clearly visible for inspection.

## 6.8 Brazil compliance (pending)

End products based on NORA-W36 series modules and targeted for distribution in Brazil must carry labels that include the ANATEL logo, NORA-W36 Homologation number TBD and a statement claiming that the device may not cause harmful interference but must accept it (Resolution No 506).



“Este equipamento opera em caráter secundário, isto é, não tem direito a proteção contra interferência prejudicial, mesmo de estações do mesmo tipo, e não pode causar interferência a sistemas operando em caráter primário.”

Statement translation:

“This equipment operates on a secondary basis and, consequently, must accept harmful interference, including from stations of the same kind, and may not cause harmful interference to systems operating on a primary basis.”

When the device is so small or for such use that it is not practicable to place the statement above on the label, the information shall be placed in a prominent location in the instruction manual or pamphlet supplied to the user or, alternatively, shall be placed on the packaging in which the device is marketed.

In cases where the final product is to be installed in locations where the end user is unable to see the ANATEL logo, NORA-W36 Homologation number and/or statement, these graphical and textual elements must be included in the end product manual.

## 6.9 Australia and New Zealand regulatory compliance (pending)



NORA-W36 modules are compliant with the standards made by the Australian Communications and Media Authority (ACMA).

The modules are compliant with AS/NZS 4268:2012 standard – Radio equipment and systems – Short range devices – Limits and methods of standard measurement. The test reports for NORA-W36 modules can be used as part of the product certification and compliance folder. [Contact](#) your local support team for more information.

To meet the overall Australian and/or New Zealand end product compliance standards, the integrator must create a compliance folder containing all the relevant compliance test reports such as RF, EMC, electrical safety and DoC (Declaration of Conformity). It is the responsibility of the integrator to know what is required in the compliance folder for ACMA compliance.

For more information on Australia compliance, refer to the Australian Communications and Media Authority web site <http://www.acma.gov.au/>.

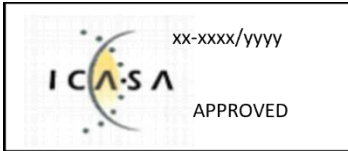
For more information on New Zealand compliance, refer to the New Zealand Radio Spectrum Management Group web site [www.rsm.govt.nz](http://www.rsm.govt.nz).

## 6.10 South Africa regulatory compliance (pending)

NORA-W36 series modules are compliant and certified by the Independent Communications Authority of South Africa (ICASA). End products that are made available for sale or lease or supplied

in any other manner in South Africa shall have a legible label permanently affixed to its exterior surface. The label shall include the ICASA logo and the ICASA issued license number, as shown in the figure below. The minimum width and height of the ICASA logo shall be 3 mm. The approval labels must be purchased by the customer's local representative directly from the approval authority ICASA.

A sample of a NORA-W36 ICASA label is shown below:



More information on registration as a Responsible Integrator and labeling requirements can be found at the following website:

Independent Communications Authority of South Africa (ICASA) web site - <https://www.icasa.org.za>

## 6.11 Approved antennas

### 6.11.1 Antenna accessories

Name	U.FL to Reverse Polarity SMA adapter cable
Applicable modules	NORA-W361, NORA-W360 For information about how to integrate the U.FL connector with the NORA-W361 <b>ANT</b> pin, see also <a href="#">NORA-W361 U.FL reference design</a> . It is necessary to follow this reference design to comply with the NORA-B1 FCC/ISED modular approvals.
Connector	U.FL and Reverse Polarity SMA jack (outer thread and pin)
Impedance	50 Ω
Minimum cable loss	0.5 dB, The cable loss must be above the minimum cable loss to meet the regulatory requirements. Minimum cable length 100 mm.
Comment	The Reverse Polarity SMA connector can be mounted in a panel.
Approval <sup>8</sup>	FCC, ISCED, RED, UKCA, MIC, KCC, ANATEL, RCM, NCC, and ICASA



### 6.11.2 Pre-approved antenna list

The following antennas are approved for use with NORA-W36:

NORA-W366	
Manufacturer	u-blox AG, licensed from Abracon
Gain <sup>9</sup>	+0.5 dBi (2.4 GHz), 2.4 dBi (5 GHz)
Impedance	N/A
Size (HxWxL)	1.1 x 3.4 x 10 mm
Type	PCB trace
Comment	PCB antenna on NORA-W366. Should not be mounted inside a metal enclosure.
Approval <sup>8</sup>	FCC, ISCED, RED, UKCA, MIC, KCC, ANATEL, RCM, NCC, and ICASA

GW.59.3153	
Manufacturer	Taoglas
Gain <sup>9</sup>	3.8 dBi (2.4 GHz), 3.2 dBi (5 GHz)
Impedance	50 Ω
Size (HxDIA)	156 x Ø13 mm
Type	Hinged dipole whip
Comment	This antenna must be mounted on a metal ground plane for best performance. It should be mounted on the U.FL to Reverse Polarity SMA adapter cable listed in <a href="#">Antenna accessories</a> .
Approval <sup>8</sup>	FCC, ISCED, RED, UKCA, MIC, KCC, ANATEL, RCM, NCC, and ICASA



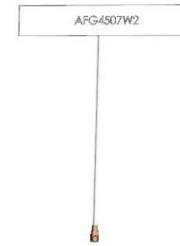
<sup>8</sup> Approvals pending

<sup>9</sup> Measured with EVK-NORA-W30



**AFG4507W2S-0200S**

Manufacturer	Abracon
Gain <sup>10</sup>	3.5 dBi (2.4 GHz), 5.3 dBi (5 GHz)
Impedance	50 $\Omega$
Size (HxWxL)	45.0 x 7.8 x 0.2 mm
Type	Flat patch
Comment	For best performance, the antenna should be attached to a plastic enclosure or part. To be connected to a U.FL connector.
Approval <sup>11</sup>	FCC, ISED, RED, UKCA, MIC, KCC, ANATEL, RCM, NCC, and ICASA


**ANTX100P001B24553**

Manufacturer	Pulse Electronics / Yageo
Gain <sup>10</sup>	5.3 dBi (2.4 GHz), 4.6 dBi (5 GHz)
Impedance	50 $\Omega$
Size (HxWxL)	50 x 10 x 2.3 mm
Type	PCB patch
Comment	Should be attached to a plastic enclosure or part for best performance. To be connected to a U.FL connector.
Approval <sup>11</sup>	FCC, ISED, RED, UKCA, MIC, KCC, ANATEL, RCM, NCC, and ICASA


**ANT-DB1-RAF-RPS**

Manufacturer	Linx Technologies, Inc.
Gain	4.1 dBi (2.4 GHz), 5.1 dBi (5 GHz)
Impedance	50 $\Omega$
Size (HxDIA)	103.7 x $\varnothing$ 11.2 mm
Type	Hinged blade whip
Connector	RP-SMA
Comment	This antenna requires to be mounted on a metal ground plane for best performance. It should be mounted on the U.FL to Reverse Polarity SMA adapter cable listed in <a href="#">Antenna accessories</a> .
Approval	FCC, ISED: approved for Bluetooth LE use only


<sup>10</sup> Measured with EVK-NORA-W30

<sup>11</sup> Approvals pending

## 7 Product testing

### 7.1 u-blox in-line production testing

As part of our focus on high quality products, u-blox maintain stringent quality controls throughout the production process. This means that all units in our manufacturing facilities are fully tested and that any identified defects are carefully analyzed to improve future production quality.

The Automatic test equipment (ATE) deployed in u-blox production lines logs all production and measurement data – from which a detailed test report for each unit can be generated. [Figure 22](#) shows the ATE typically used during u-blox production.

u-blox in-line production testing includes:

- Digital self-tests (firmware download, MAC address programming)
- Measurement of voltages and currents
- Functional tests (host interface communication)
- Digital I/O tests
- Measurement and calibration of RF characteristics in all supported bands, including RSSI calibration, frequency tuning of reference clock, calibration of transmitter power levels, etc.
- Verification of Wi-Fi and Bluetooth RF characteristics after calibration, like modulation accuracy, power levels, and spectrum, are checked to ensure that all characteristics are within tolerance when the calibration parameters are applied.



**Figure 22: Automatic test equipment for module test**

## 7.2 OEM manufacturer production test

As all u-blox products undergo thorough in-series production testing prior to delivery, OEM manufacturers don't need to repeat any firmware tests or measurements that might otherwise be necessary to confirm RF performance. Testing over analog and digital interfaces is also unnecessary during an OEM production test.

OEM manufacturer testing should ideally focus on:

- Module assembly on the device; it should be verified that:
  - Soldering and handling process did not damage the module components
  - All module pins are well soldered on the application board
  - There are no short circuits between pins
- Component assembly on the device; it should be verified that:
  - Communication with host controller can be established
  - The interfaces between module and device are working
  - Overall RF performance test of the device including antenna


In addition to this testing, OEMs can also perform other dedicated tests to check the device. For example, the measurement of module current consumption in a specified operating state can identify a short circuit if the test result deviates that from that taken against a "Golden Device".

The standard operational module firmware and test software on the host can be used to perform functional tests (communication with the host controller, check interfaces) and perform basic RF performance testing. Special manufacturing firmware can also be used to perform more advanced RF performance tests.

## 7.3 "Go/No go" tests for integrated devices

A "Go/No go" test compares the signal quality of the Device under Test (DUT) with that of "Golden Device" in a location with a known signal quality. This test can be performed after establishing a connection with an external device.

A very simple test can be performed by just scanning for a known Bluetooth low energy device and checking that the signal level (Received Signal Strength Indicator (RSSI)) is acceptable.

 Tests of this kind may be useful as a "go/no go" test but are not appropriate for RF performance measurements.

Go/No go tests are suitable for checking communication between the host controller and the power supply. The tests can also confirm that all components on the DUT are well soldered.

A basic RF functional test of the device that includes the antenna can be performed with standard Bluetooth low energy devices configured as remote stations. In this scenario, the device containing NORA-W36 and the antennas should be arranged in a fixed position inside an RF shield box. The shielding prevents interference from other possible radio devices to ensure stable test results.

## Appendix

### A Reference trace design (NORA-W3x1 only)

Designers can take full advantage of the NORA-W3 Single-Modular Transmitter certification approval for NORA-W3x1 by integrating the u-blox reference design described in this appendix into their products. This approach requires compliance with the following rules:

- Only listed antennas can be used. Refer to [Approved antennas](#) for the listed antennas.
- Schematics and parts used in the design must be identical to the reference design. Use only parts validated by u-blox for antenna matching.
- PCB layout of the RF section must be identical to the one provided by u-blox. The reference design described in this section must be used.
- The designer must use the four-layer PCB stack-up provided by u-blox. RF traces on the carrier PCB are part of the certified design.

The reference design uses a U.FL micro-coaxial connector to connect the external antenna via a 50  $\Omega$  coaxial cable. [Figure 23](#) shows the placement of the connector in relation and module footprint. The components connected to the RF trace must be kept as shown in the reference design.

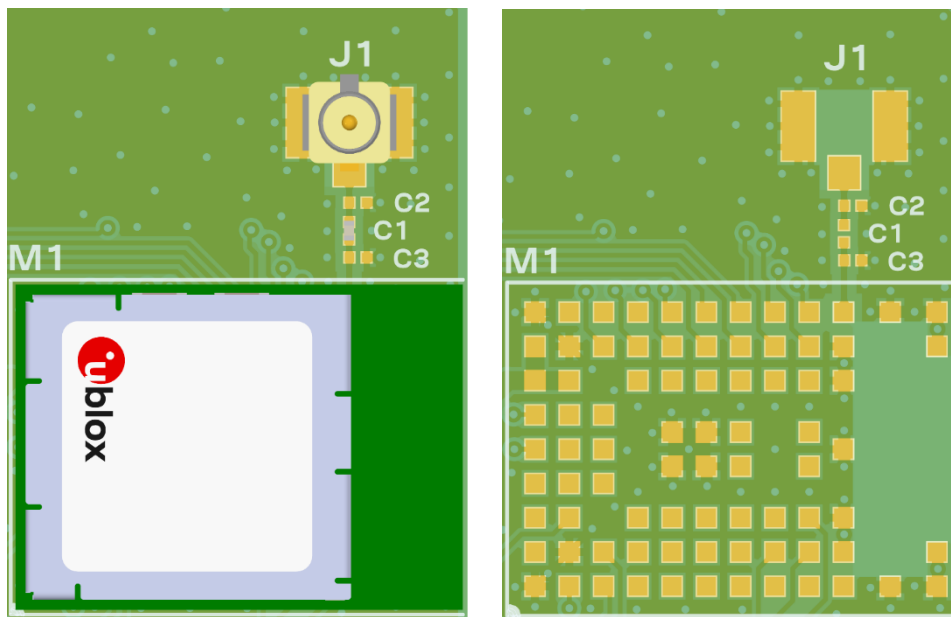


Figure 23: U.FL connector placement (left) and module footprint (right)

- The layout used for certification accommodated any of the variants of NORA-W3. A keep-out is present under the NORA-W3 module to accommodate the NORA-W3x6 variant. When used with a NORA-W3x1, the keep-out under the module is not required. See [Figure 24](#).

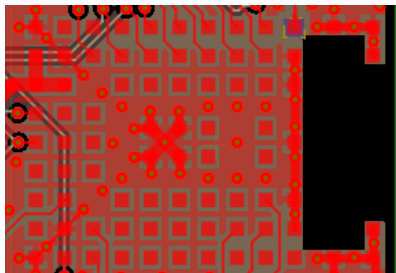


Figure 24: NORA-W3x6 keepout – not required for NORA-W3x1

## A.1 Floor plan

Figure 25 shows the critical components and positioning of the copper traces in the reference design. The itemized references are described in Table 12.

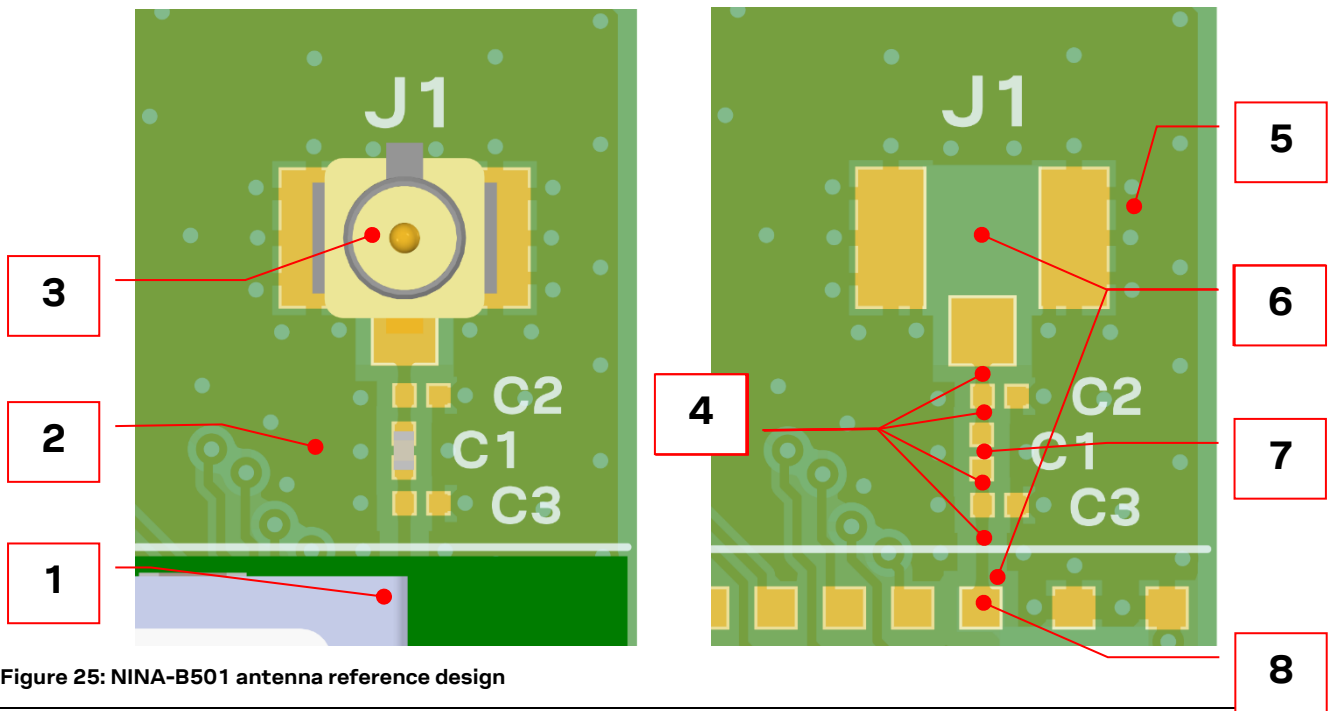


Figure 25: NINA-B501 antenna reference design


Reference	Part	Manufacturer	Description
1	NORA-W3x1	u-blox	NORA-W3 module with antenna pin
2	Carrier PCB		Must have a solid GND inner second and third layers underneath and around the RF components (vias and small openings are allowed). See Figure 27 and Figure 28 for copper keep-out requirements.
3	U.FL-R-SMT-1(10)	Hirose	Coaxial connector, 0 – 6 GHz, for external antenna
4	RF trace		Antenna coplanar microstrip, matched to 50 $\Omega$
5	GND copper pour		Minimum required top layer ground pour. Minimum 1.3 mm surrounding U.FL connector and RF traces
6	Copper keep-out		Keep this area free from any copper on the top and second layers See Figure 27 and Figure 28 for additional requirements.
7	GRM0335C1H100GA01	Murata	C1: Size 0201, 10 pF C0G RF matching capacitor  C2 and C3 are not populated
8	RF pin		RF pin on NORA-W3 footprint.

Table 12: Antenna reference design – item descriptions

## A.2 RF trace specification and PCB stack-up

The RF trace is a 50  $\Omega$  coplanar micro-strip using the dimensions layer stack-up described in [Table 14](#).

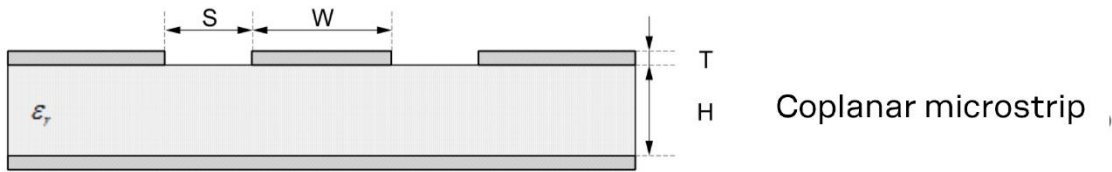


Figure 26: Coplanar micro-strip dimensions

Reference	Item	Value
S	Spacing	$300 \pm 50 \mu\text{m}$
W	Conductor width	$195 \pm 30 \mu\text{m}$ (match as close to 50 $\Omega$ as possible)
T	Copper and plating/surface coating thickness	$35 \pm 15 \mu\text{m}$
H	Conductor height	See <a href="#">Table 14</a>
$\epsilon_r$	Dielectric constant (relative permittivity)	See <a href="#">Table 14</a>

Table 13: Coplanar micro-strip dimensions for top layer only

Layer	Name	Material	Type	Weight	Thickness ( $\mu\text{m}$ )	Dielectric constant
	Top overlay	Overlay	Overlay			
	Top soldermask	Solder resist	Solder mask		12.7	3.5
1	Layer 1	Copper	Signal	1 oz	35	
	Dielectric 1	Composite dielectric	Prepreg		110	4.29
2	Layer 2	Copper	Signal	1 oz	35	
	Core	Composite dielectric	Core		1200	4.29
3	Layer 3	Copper	Signal	1 oz	35	
	Dielectric 3	Composite dielectric	Prepreg		110	4.29
4	Layer 4	Copper	Signal	1 oz	35	
	Bottom soldermask	Solder resist	Solder mask		12.7	3.5
	Bottom overlay	Overlay	Overlay			

Table 14: Carrier PCB stack-up

### A.2.1 Ground stitching vias

Immediately beyond the micro-strip spacing, a series of ground stitching vias is required directly surrounding RF components and traces. Figure 27 shows the minimum arrangement of stitching vias. Additional ground stitching vias are recommended.

### A.2.2 Keep out areas

There are keep-out areas on layers 1 and 2, around the U.FL connector and RF pin of the NORA-W3x1 module. The micro-strip spacing accounts for the layer 1 keep-out around the module RF pin. The U.FL connector requires that there be no copper underneath. See [Figure 27](#).

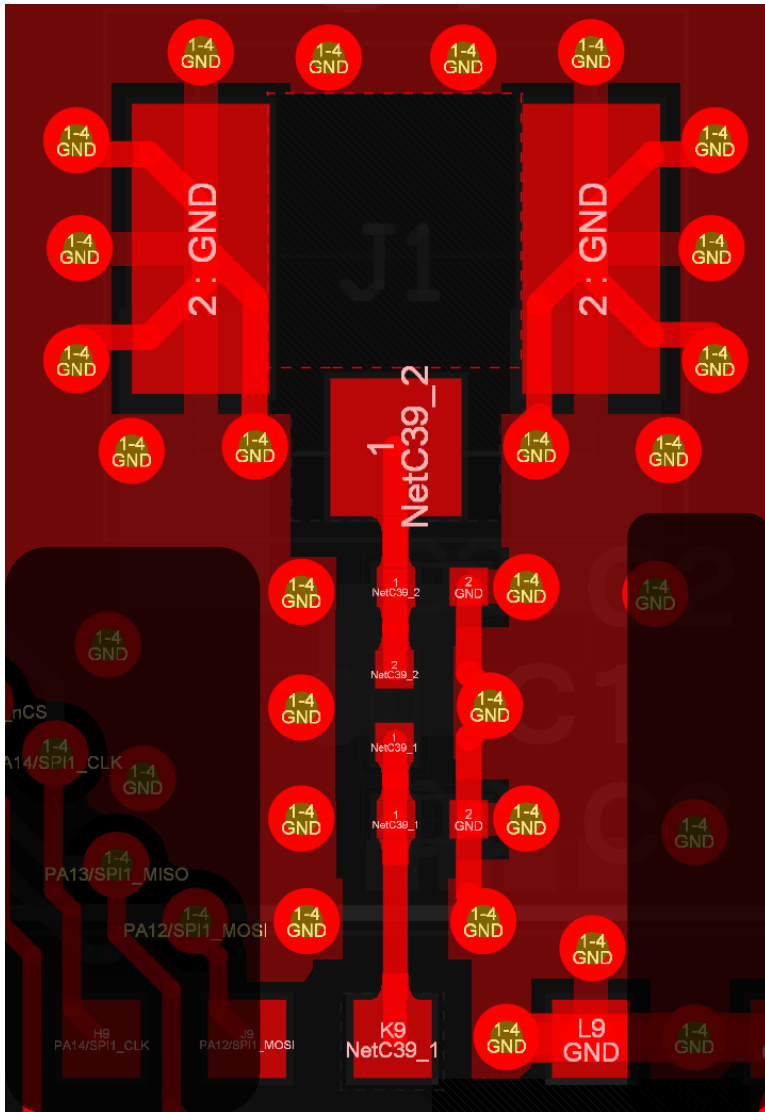
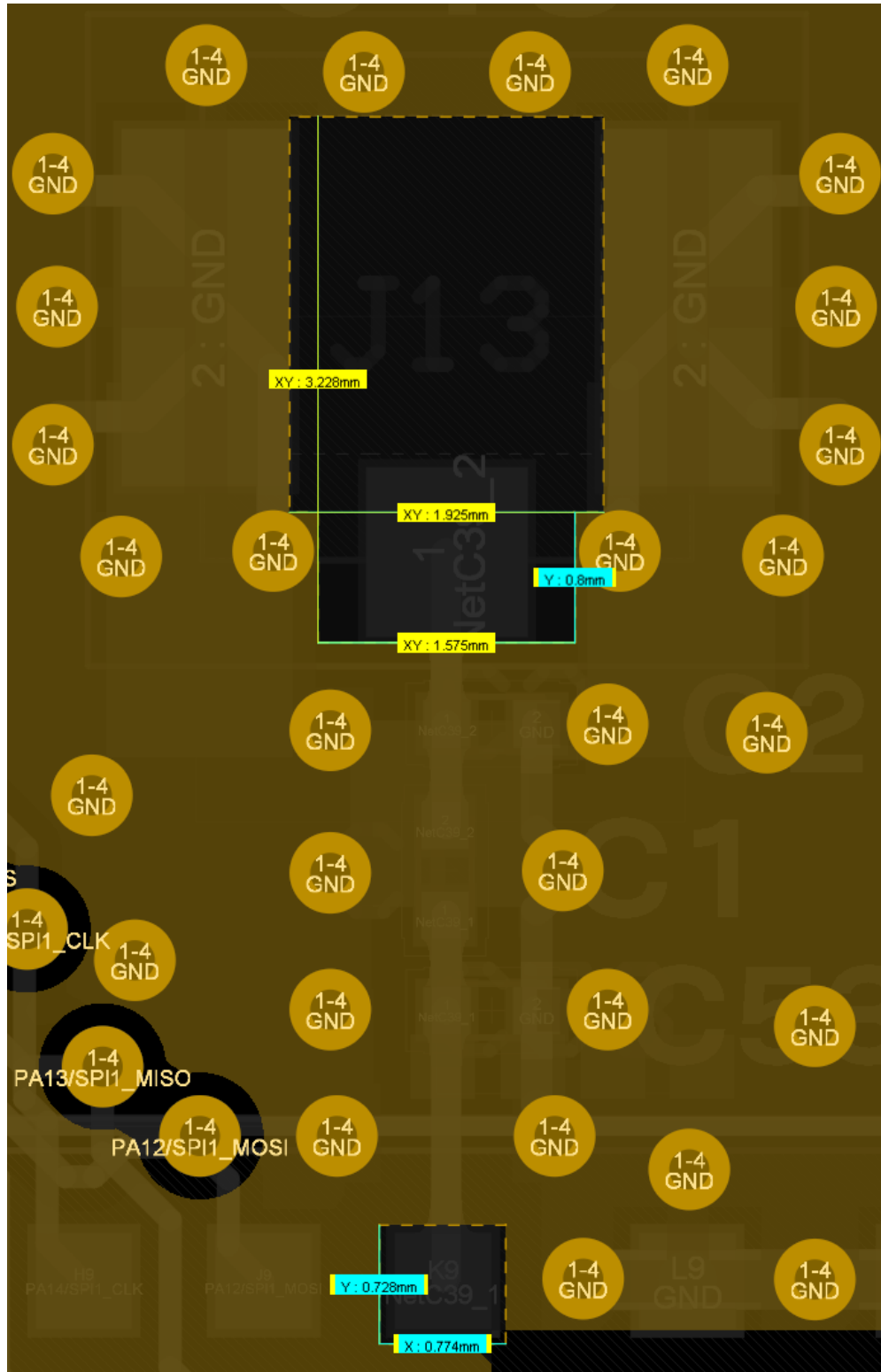


Figure 27: Layer 1 routing, keep-out, and ground stitching vias

On layer 2, the keep-out under the U.FL is duplicated, including the spacing around the U.FL RF pad on layer 1. Also on layer 2, a keep-out under the RF pad of the NORA-W3x1 module is required. See [Figure 28](#).



**Figure 28: Layer 2 keep-out areas**

Layer 3 must be a solid ground plane in this area.

Layer 4 is available for signal routing.



### A.2.3 Component placement

In addition to the U.FL connector and module RF pin, three size 0201 component locations are included in the trace design, designated as C1, C2 and C3. Only C1, the series capacitor, is populated. The C2 and C3 locations are necessary to match the trace design as it was certified and are not to be populated. Figure 29 shows measurements between the centers of each of the pads in the RF path.

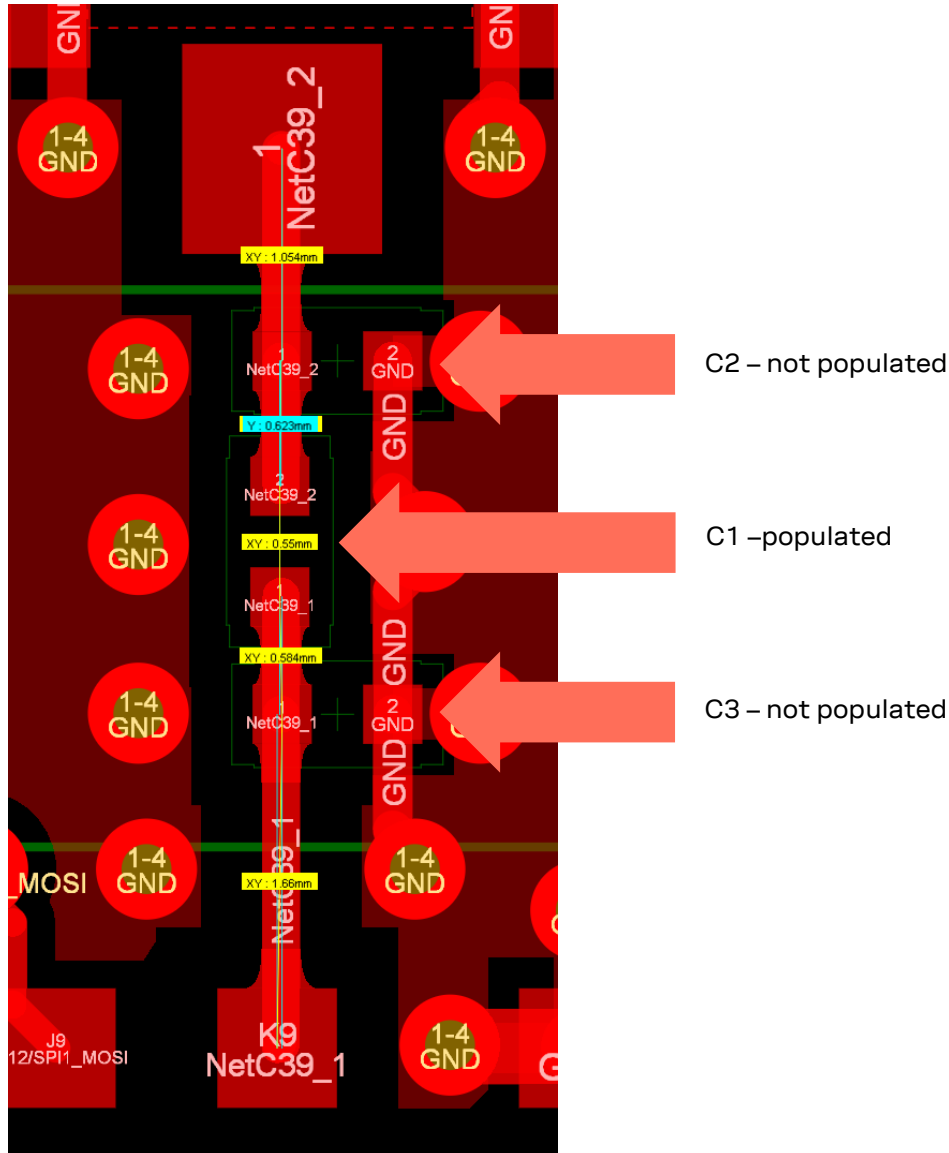


Figure 29: RF trace design component placement

## B Glossary


Abbreviation	Definition
ADC	Analog to Digital Converter
ARM	Arm (Advanced RISC Machines) Holdings
ATE	Automatic Test Equipment
CPU	Central Processing Unit
DCE	Data Circuit-terminating Equipment* / Data Communication Equipment*
DUT	Device Under Test
EMC	ElectroMagnetic Compatibility
EMI	ElectroMagnetic Interference
ESD	ElectroStatic Discharge
FCC	Federal Communications Commission (United States)
GATT	Generic Attribute
GPIO	General Purpose Input / Output
I2C	Inter-Integrated Circuit
ISED	Innovation, Science, and Economic Development (Canada)
KDB	Knowledge DataBase (of the FCC)
LDO	Low Drop-Out
LE	Low Energy
LGA	Land Grid Array
MAC	Media Access Control
MCU	MicroController Unit
MSL	Moisture Sensitivity Level
NMSD	Non-Solder Mask Defined
OEM	Original Equipment Manufacturer
OET	Office of Engineering and Technology (of the FCC)
OTP	One-Time Programmable
PCB	Printed Circuit Board
PCBA	Printed Circuit Board Assembly
RAM	Random Access Memory
RF	Radio Frequency
RTC	Real-Time Clock
SMPS (also SPS)	Switch Mode Power Supply
SMA	SubMiniature version A connector
SMT	Surface Mount Technology
THT	Through-Hole Technology
TLS	Transport Layer Security
UART	Universal Asynchronous Receiver Transmitter
VSWR	Voltage Standing Wave Ratio
WPA	Wi-Fi Protected Access

**Table 15: Explanation of the abbreviations and terms used**

## Related documentation

- [1] Package information guide, [UBX-14001652](#)
- [2] NORA-W36 data sheet, [UBX-22021118](#)

- [3] JEDEC: Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices, [J-STD-020E](#)
- [4] IEC: Electromagnetic compatibility (EMC) - Part 4-2: Testing and measurement techniques – Electrostatic discharge immunity test, [IEC 61000-4-2:2008](#)
- [5] IEC: Electrostatics - Part 5-1: Protection of electronic devices from electrostatic phenomena - General requirements, [IEC 61340-5-1:2016](#)
- [6] ETSI: Electromagnetic compatibility and Radio spectrum Matters (ERM); ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements, [EN 301 489-1 v2.2.3](#)
- [7] ETSI: Audio/video, information, and communication technology equipment - Part 1: Safety requirements, [IEC 62368-1:2018](#)
- [8] FCC guidance [594280 D01 Configuration Control v02 r01](#),
- [9] FCC guidance [594280 D02 U-NII Device Security v01r03](#)
- [10] NORA-W3 ETSI Declaration of Conformity (TBC)
- [11] NORA-W3 UKCA Declaration of Conformity (TBC)
- [12] u-connectXpress AT command manual for NORA-W36, [UBX-23010166](#)
- [13] u-connectXpress User guide for NORA-W36, [UBX-23008692](#)
- [14] s-center 2, [s-center 2 product page](#)

 For product change notifications and regular updates of u-blox documentation, register on our website, [www.u-blox.com](http://www.u-blox.com).

## Revision history

Revision	Date	Name	Comments
R01	16-Oct-2023	brec	Initial release
R02	27-Mar-2024	brec	Updated product status in Document information, updated certification labeling requirements in <a href="#">Regulatory compliance</a> , updated <a href="#">Software configuration and control</a> , updated Bluetooth to Bluetooth 5.3, updated design for <a href="#">NORA-W361 U.FL reference design</a> including <a href="#">Figure 4</a> .
R02_cert	27-Mar-2024	brec	Update for certification submission
R03_cert	30-Apr-2024	brec	Added <a href="#">Reference trace design (NORA-W3x1 only)</a>
R04_cert	01-May-2024	brec	Included individual references for Taiwan certification numbers.
R05_cert	20-May-2024	brec	Included TE-Linx ANT-DB1-RAF-RPS antenna for FCC, ISED Bluetooth LE

## Contact

For further support and contact information, visit us at [www.u-blox.com/support](http://www.u-blox.com/support).